

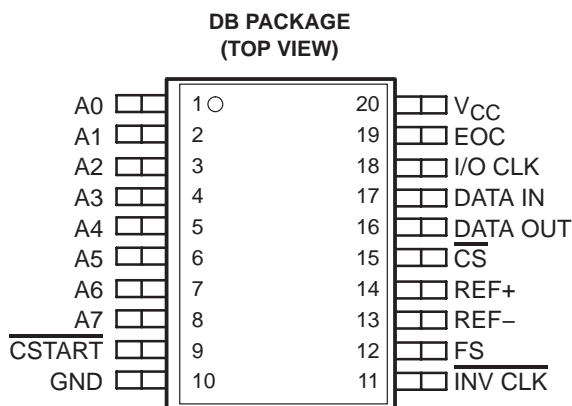
TLV1548-EP

LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

- **Controlled Baseline**
 - One Assembly Site, One Test Site, One Fabrication Site
- **Extended Temperature Performance of –40°C to 125°C**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product-Change Notification**
- **Qualification Pedigree†**
- **Conversion Time $\leq 10 \mu\text{s}$**
- **10-Bit-Resolution ADC**
- **Programmable Power-Down Mode . . . 1 μA**
- **Wide Range Single-Supply Operation of 2.7 V dc to 5.5 V dc**
- **Analog Input Range of 0 V to V_{CC}**
- **Built-in Analog Multiplexer with 8 Analog Input Channels**
- **TMS320 DSP and Microprocessor SPI and QSPI Compatible Serial Interfaces**
- **End-of-Conversion (EOC) Flag**
- **Inherent Sample-and-Hold Function**
- **Built-In Self-Test Modes**
- **Programmable Power and Conversion Rate**
- **Asynchronous Start of Conversion for Extended Sampling**
- **Hardware I/O Clock Phase Adjust Input**

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.



description

The TLV1548 is a CMOS 10-bit switched-capacitor successive-approximation (SAR) analog-to-digital (A/D) converter. The device has a chip select (\overline{CS}), input-output clock (I/O CLK), data input (DATA IN) and serial data output (DATA OUT) that provides a direct 4-wire synchronous serial peripheral interface (SPI™, QSPI™) port of a host microprocessor. When interfacing with a TMS320 DSP, an additional frame sync signal (FS) indicates the start of a serial data frame. The device allows high-speed data transfers from the host. The $\overline{INV CLK}$ input provides further timing flexibility for the serial interface.

In addition to a high-speed converter and versatile control capability, the device has an on-chip 11-channel multiplexer that can select any one of eight analog inputs or any one of three internal self-test voltages. The sample-and-hold function is automatic except for the extended sampling cycle, where the sampling cycle is started by the falling edge of asynchronous \overline{CSTART} . At the end of the A/D conversion, the end-of-conversion (EOC) output goes high to indicate that the conversion is complete. The TLV1548 is designed to operate with a wide range of supply voltages with very low power consumption. The power saving feature is further enhanced with a software-programmed power-down mode and conversion rate. The converter incorporated in the device features differential high-impedance reference inputs that facilitate ratiometric conversion, scaling, and isolation of analog circuitry from logic and supply noise. A switched-capacitor design allows low-error conversion over the full operating temperature range.

The TLV1548 has eight analog input channels. The TLV1548Q is characterized for operation from –40°C to 125°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SPI and QSPI are registered trademarks of Motorola, Inc.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



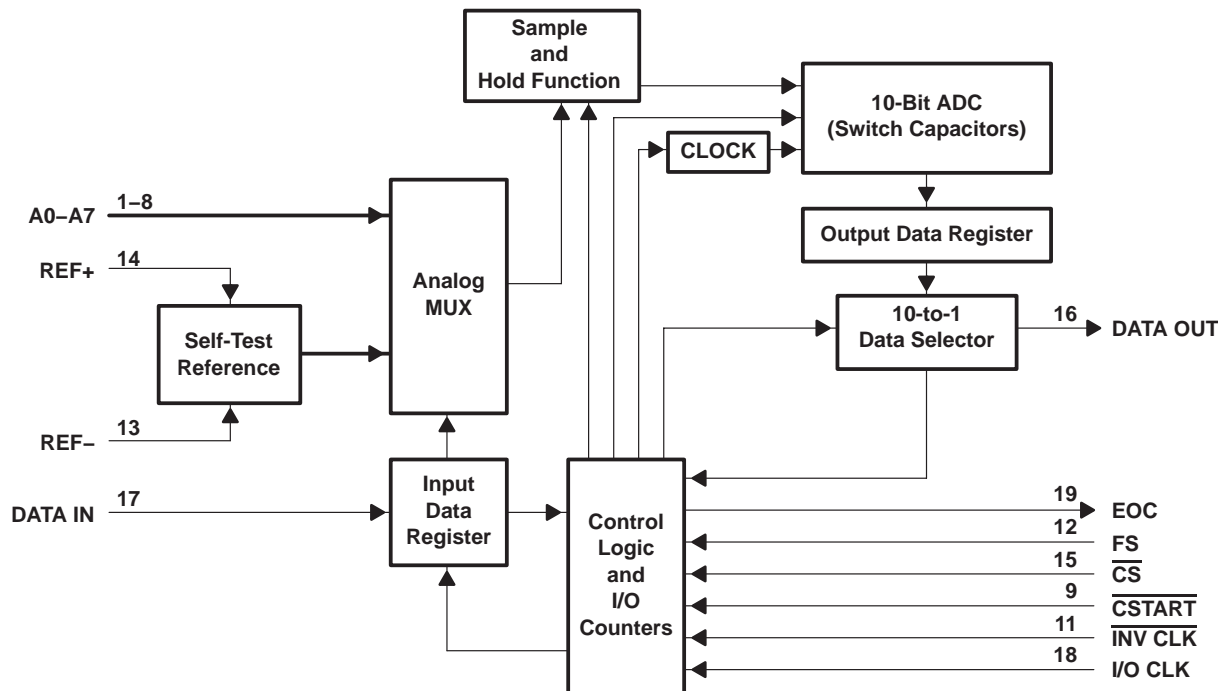
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2003 Texas Instruments Incorporated

TLV1548-EP LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

functional block diagram



Terminals shown are for the DB package.

ORDERING INFORMATION

| TA | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|---------------|-----------------------|------------------|
| -40°C to 125°C | SSOP – DB | Tape and reel | TLV1548QDBREP | 1548QE |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

Terminal Functions

| TERMINAL NAME | NO. | I/O | DESCRIPTION |
|-----------------------------|------------|-----|--|
| A0–A3 A4–A7 | 1–4 5–8 | I | Analog inputs. The analog inputs are internally multiplexed. (For a source impedance greater than 1 k Ω , the asynchronous start should be used to increase the sampling time.) |
| $\overline{\text{CS}}$ | 15 | I | Chip select. A high-to-low transition on $\overline{\text{CS}}$ resets the internal counters and controls and enables DATA IN, DATA OUT, and I/O CLK within the maximum setup time. A low-to-high transition disables DATA IN, DATA OUT, and I/O CLK within the setup time. |
| $\overline{\text{CSTART}}$ | 9 | I | Sampling/conversion start control. $\overline{\text{CSTART}}$ controls the start of the sampling of an analog input from a selected multiplex channel. A high-to-low transition starts the sampling of the analog input signal. A low-to-high transition puts the sample-and-hold function in hold mode and starts the conversion. $\overline{\text{CSTART}}$ is independent from I/O CLK and works when $\overline{\text{CS}}$ is high. The low $\overline{\text{CSTART}}$ duration controls the duration of the sampling cycle for the switched capacitor array. $\overline{\text{CSTART}}$ is tied to V_{CC} if not used. |
| DATA IN | 17 | I | Serial data input. The 4-bit serial data selects the desired analog input and test voltage to be converted next in a normal cycle. These bits can also set the conversion rate and enable the power-down mode. When operating in the microprocessor mode, the input data is presented MSB first and is shifted in on the first four rising ($\text{INV CLK} = V_{\text{CC}}$) or falling ($\text{INV CLK} = \text{GND}$) edges of I/O CLK (after $\overline{\text{CS}}\downarrow$). When operating in the DSP mode, the input data is presented MSB first and is shifted in on the first four falling ($\text{INV CLK} = V_{\text{CC}}$) or rising ($\text{INV CLK} = \text{GND}$) edges of I/O CLK (after $\text{FS}\downarrow$). After the four input data bits have been read into the input data register, DATA IN is ignored for the remainder of the current conversion period. |
| DATA OUT | 16 | O | Three-state serial output of the A/D conversion result. DATA OUT is in the high-impedance state when $\overline{\text{CS}}$ is high and active when $\overline{\text{CS}}$ is low or after $\text{FS}\downarrow$ (in DSP mode). With a valid $\overline{\text{CS}}$ signal, DATA OUT is removed from the high-impedance state and is driven to the logic level corresponding to the MSB or LSB value of the previous conversion result. DATA OUT changes on the falling (microprocessor mode) or rising (DSP mode) edge of I/O CLK. |
| EOC | 19 | O | End of conversion. EOC goes from a high to a low logic level on the tenth rising (microprocessor mode) or tenth falling (DSP mode) edge of I/O CLK and remains low until the conversion is complete and data is ready for transfer. EOC can also indicate that the converter is busy. |
| FS | 12 | I | DSP frame synchronization input. FS indicates the start of a serial data frame into or out of the device. FS is tied to V_{CC} when interfacing the device with a microprocessor. |
| GND | 10 | | Ground return for internal circuitry. All voltage measurements are with respect to GND, unless otherwise noted. |
| $\overline{\text{INV CLK}}$ | 11 | I | Inverted clock input. $\overline{\text{INV CLK}}$ is tied to GND when an inverted I/O CLK is used as the source of the input clock. This affects both microprocessor and DSP interfaces. $\overline{\text{INV CLK}}$ is tied to V_{CC} if I/O CLK is not inverted. $\overline{\text{INV CLK}}$ can also invoke a built-in test mode. |

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

Terminal Functions (Continued)

| TERMINAL NAME | NO. | I/O | DESCRIPTION |
|---------------|-----|-----|--|
| I/O CLK | 18 | I | <p>Input/output clock. I/O CLK receives the serial I/O clock input in the two modes and performs the following four functions in each mode:</p> <p>Microprocessor mode</p> <ul style="list-style-type: none"> When $\overline{\text{INVCLK}} = V_{\text{CC}}$, I/O CLK clocks the four input data bits into the input data register on the first four rising edges of I/O CLK after $\overline{\text{CS}}\downarrow$ with the multiplexer address available after the fourth rising edge. When $\overline{\text{INV CLK}} = \text{GND}$, input data bits are clocked in on the first four falling edges instead. On the fourth falling edge of I/O CLK, the analog input voltage on the selected multiplex input begins charging the capacitor array and continues to do so until the tenth rising edge of I/O CLK except in the extended sampling cycle where the duration of $\overline{\text{CSTART}}$ determines when to end the sampling cycle. Output data bits change on the first ten falling I/O clock edges regardless of the condition of $\overline{\text{INV CLK}}$. I/O CLK transfers control of the conversion to the internal state machine on the tenth rising edge of I/O CLK regardless of the condition of $\overline{\text{INV CLK}}$. <p>Digital signal processor (DSP) mode</p> <ul style="list-style-type: none"> When $\overline{\text{INV CLK}} = V_{\text{CC}}$, I/O CLK clocks the four input data bits into the input data register on the first four falling edges of I/O CLK after $\text{FS}\downarrow$ with the multiplexer address available after the fourth falling edges. When $\overline{\text{INV CLK}} = \text{GND}$, input data bits are clocked in on the first four rising edges instead. On the fourth rising edge of I/O CLK, the analog input voltage on the selected multiplex input begins charging the capacitor array and continues to do so until the tenth falling edge of I/O CLK except in the extended sampling cycle where the duration of $\overline{\text{CSTART}}$ determines when to end the sampling cycle. Output data MSB shows after $\text{FS}\downarrow$ and the rest of the output data bits change on the first ten rising I/O CLK edges regardless of the condition of $\overline{\text{INV CLK}}$. I/O CLK transfers control of the conversion to the internal state machine on the tenth falling edge of I/O CLK regardless of the condition of $\overline{\text{INV CLK}}$. |
| REF+ | 14 | I | Upper reference voltage (nominally V_{CC}). The maximum input voltage range is determined by the difference between the voltages applied to REF+ and REF-. |
| REF- | 13 | I | Lower reference voltage (nominally ground) |
| VCC | 20 | I | Positive supply voltage |

detailed description

Initially, with $\overline{\text{CS}}$ high (inactive), DATA IN and I/O CLK are disabled and DATA OUT is in the high-impedance state. When the serial interface takes $\overline{\text{CS}}$ low (active), the conversion sequence begins with the enabling of I/O CLK and DATA IN and the removal of DATA OUT from the high-impedance state. The host then provides the 4-bit channel address to DATA IN and the I/O clock sequence to I/O CLK. During this transfer, the host serial interface also receives the previous conversion result from DATA OUT. I/O CLK receives an input sequence from the host that is from 10 to 16 clocks long. The first four valid I/O CLK cycles load the input data register with the 4-bit input data on DATA IN that selects the desired analog channel. The next six clock cycles provide the control timing for sampling the analog input. Sampling of the analog input is held after the first valid I/O CLK sequence of ten clocks. The tenth clock edge also takes EOC low and begins the conversion. The exact locations of the I/O clock edges depend on the mode of operation.

serial interface

The TLV1548 is compatible with generic microprocessor serial interfaces such as SPI and QSPI, and a TMS320 DSP serial interface. The internal latched flag If_mode is generated by sampling the state of FS at the falling edge of $\overline{\text{CS}}$. If_mode is set to one (for microprocessor) when FS is high at the falling edge of $\overline{\text{CS}}$, and If_mode is cleared to zero (for DSP) when FS is low at the falling edge of $\overline{\text{CS}}$. This flag controls the multiplexing of I/O CLK and the state machine reset function. FS is pulled high when interfacing with a microprocessor.



TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

I/O CLK

The I/O CLK can go up to 10 MHz for most of the voltage range when fast I/O is possible. The maximum I/O CLK is limited to 2.8 MHz for a supply voltage range from 2.7 V. Table 1 lists the maximum I/O CLK frequencies for all different supply voltage ranges. This also depends on input source impedance. For example, I/O CLK speed faster than 2.39 MHz is achievable if the input source impedance is less than 1 k Ω .

Table 1. Maximum I/O CLK Frequency

| V _{CC} | MAXIMUM INPUT RESISTANCE (Max) | SOURCE IMPEDANCE | I/O CLK |
|-----------------|--------------------------------|------------------|----------|
| 2.7 V | 5 K | 1 k Ω | 2.39 MHz |
| | | 100 Ω | 2.81 MHz |
| 4.5 V | 1 K | 1 k Ω | 7.18 MHz |
| | | 100 Ω | 10 MHz |

microprocessor serial interface

Input data bits from DATA IN are clocked in on the first four rising edges of the I/O CLK sequence if $\overline{\text{INV CLK}}$ is held high when the device is in microprocessor interface mode. Input data bits are clocked in on the first four falling edges of the I/O CLK sequence if $\overline{\text{INV CLK}}$ is held low. The MSB of the previous conversion appears on DATA OUT on the falling edge of $\overline{\text{CS}}$. The remaining nine bits are shifted out on the next nine edges (depending on the state of $\overline{\text{INV CLK}}$) of I/O CLK. Ten bits of data are transmitted to the host through DATA OUT.

A minimum of 9.5 clock pulses is required for the conversion to begin. On the tenth clock rising edge, the EOC output goes low and returns to the high logic level when the conversion is complete; then the result can be read by the host. On the tenth clock falling edge, the internal logic takes DATA OUT low to ensure that the remaining bit values are zero if the I/O CLK transfer is more than ten clocks long.

$\overline{\text{CS}}$ is inactive (high) between serial I/O CLK transfers. Each transfer takes at least ten I/O CLK cycles. The falling edge of $\overline{\text{CS}}$ begins the sequence by removing DATA OUT from the high-impedance state. The rising edge of $\overline{\text{CS}}$ ends the sequence by returning DATA OUT to the high-impedance state within the specified delay time. Also, the rising edge of $\overline{\text{CS}}$ disables I/O CLK and DATA IN within a setup time. A conversion does not begin until the tenth I/O CLK rising edge.

A high-to-low transition on $\overline{\text{CS}}$ within the specified time during an ongoing cycle aborts the cycle, and the device returns to the initial state (the output data register holds the previous conversion result). $\overline{\text{CS}}$ should not be taken low close to completion of conversion because the output data can be corrupted.



TLV1548-EP

LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

DSP interface

The TLV1548 can also interface with a DSP, from the TMS320 family for example, through a serial port. The analog-to-digital converter (ADC) serves as a slave device where the DSP supplies FS and the serial I/O CLK. Transmit and receive operations are concurrent. The falling edge of FS must occur no later than seven I/O CLK periods after the falling edge of \overline{CS} .

DSP I/O cycles differ from microprocessor I/O cycles in the following ways:

- When interfaced with a DSP, the output data MSB is available after FS \downarrow . The remaining output data changes on the rising edge of I/O CLK. The input data is sampled on the first four falling edges of I/O CLK after FS \downarrow and when INV CLK is high, or the first four rising edges of I/O CLK after FS \downarrow and when INV CLK is low. This operation is inverted when interfaced with a microprocessor.
- A new DSP I/O cycle is started on the rising edge of I/O CLK after the rising edge of FS. The internal state machine is reset on each falling edge of I/O CLK when FS is high. This operation is opposite when interfaced with a microprocessor.
- The TLV1548 supports a 16-clock cycle when interfaced with a DSP. The output data is padded with six trailing zeros when it is operated in DSP mode.

Table 2. TLV1548 Serial Interface Modes

| I/O | INTERFACE MODE | |
|---------------------------|---|--|
| | MICROPROCESSOR ACTION | DSP ACTION |
| $\overline{CS}\downarrow$ | Initializes counter | Samples state of FS |
| $\overline{CS}\uparrow$ | Resets state machine and disable I/O | Disables I/O |
| FS | Connects to V _{CC} | Connects to DSP FSX output Initializes the state machine at each CLK \downarrow after FS \uparrow Starts a new cycle at each CLK \uparrow following the initialization (initializes the counter) |
| I/O CLK | Starts sampling of the analog input started at fourth I/O CLK \uparrow Conversion started at tenth I/O CLK \uparrow | Starts sampling of the analog input at fourth I/O CLK \downarrow Starts sampling of the analog input at tenth I/O CLK \downarrow |
| DATA IN | Samples input data on I/O CLK \uparrow ($\overline{INV CLK}$ high) Samples input data on I/O CLK \downarrow ($\overline{INV CLK}$ low) | Samples input data at I/O CLK \downarrow ($\overline{INV CLK}$ high) Samples input data at I/O CLK \uparrow ($\overline{INV CLK}$ low) |
| DATA OUT | Makes MSB available on $\overline{CS}\downarrow$ Changes remaining data on I/O CLK \downarrow | Makes MSB available FS \downarrow Changes remaining data at each following I/O CLK \uparrow after FS \downarrow |

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

input data bits

DATA IN is internally connected to a 4-bit serial input data register. The input data selects a different mode or selects different analog input channels. The host provides the data word with the MSB first. Each data bit clocks in on the edge (rising or falling depending on the status of $\overline{\text{INV CLK}}$ and FS) of the I/O CLK sequence. The input clock can be inverted by grounding $\overline{\text{INV CLK}}$ (see Table 3 for the list of software programmed operations set by the input data).

Table 3. TLV1548 Software-Programmed Operation Modes

| FUNCTION SELECT | INPUT DATA BYTE | | COMMENT |
|--|-----------------|-----|---|
| | A3 – A0 | | |
| | BINARY | HEX | |
| Analog channel A0 for TLV1548 selected | 0000b | 0h | |
| Analog channel A1 for TLV1548 selected | 0001b | 1h | |
| Analog channel A2 for TLV1548 selected | 0010b | 2h | |
| Analog channel A3 for TLV1548 selected | 0011b | 3h | |
| Analog channel A4 for TLV1548 selected | 0100b | 4h | |
| Analog channel A5 for TLV1548 selected | 0101b | 5h | |
| Analog channel A6 for TLV1548 selected | 0110b | 6h | |
| Analog channel A7 for TLV1548 selected | 0111b | 7h | |
| Software power down set | 1000b | 8h | No conversion result (cleared by any access) |
| Fast conversion rate (10 μ s) set | 1001b | 9h | No conversion result (cleared by setting to fast) |
| Slow conversion rate (40 μ s) set | 1010b | Ah | No conversion result (cleared by setting to slow) |
| Self-test voltage ($V_{\text{ref}+} - V_{\text{ref}-}$)/2 selected | 1011b | Bh | Output result = 200h |
| Self-test voltage $V_{\text{ref}-}$ selected | 1100b | Ch | Output result = 000h |
| Self-test voltage $V_{\text{ref}+}$ selected | 1101b | Dh | Output result = 3FFh |
| Reserved | 1110b | Eh | No conversion result |
| Reserved | 1111b | Fh | No conversion result |

analog inputs and internal test voltages

The eight analog inputs and the three internal test inputs are selected by the 11-channel multiplexer according to the input data bit as shown in Table 3. The input multiplexer is a break-before-make type to reduce input-to-input noise injection resulting from channel switching.

The device can be operated in two distinct sampling modes: normal sampling mode (fixed sampling time) and extended sampling mode (flexible sampling time). When $\overline{\text{CSTART}}$ is held high, the device is operated in normal sampling mode. When operated in normal sampling mode, sampling of the analog input starts on the rising edge of the fourth I/O CLK pulse in the microprocessor interface mode (and on the fourth falling edge of I/O CLK in the DSP interface mode). Sampling continues for 6 I/O CLK periods. The sample is held on the falling edge of the tenth I/O CLK pulse in the microprocessor interface mode. The sample is held on the falling edge of the tenth I/O CLK pulse in the DSP interface mode. The three test inputs are applied to the multiplexer, then sampled and converted in the same manner as the external analog inputs.



TLV1548-EP LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

converter

The CMOS threshold detector in the successive-approximation conversion system determines the value of each bit by examining the charge on a series of binary-weighted capacitors (see Figure 1). In the first phase of the conversion process, the analog input is sampled by closing the S_C switch and all S_T switches simultaneously. This action charges all of the capacitors to the input voltage.

In the next phase of the conversion process, all S_T and S_C switches are opened and the threshold detector begins identifying bits by identifying the charge (voltage) on each capacitor relative to the reference (REF –) voltage. In the switching sequence, ten capacitors are examined separately until all ten bits are identified and then the charge-convert sequence is repeated. In the first step of the conversion phase, the threshold detector looks at the first capacitor (weight = 512). Node 512 of this capacitor is switched to the REF+ voltage, and the equivalent nodes of all the other capacitors on the ladder are switched to REF –. If the voltage at the summing node is greater than the trip point of the threshold detector (approximately one-half V_{CC}), a bit 0 is placed in the output register and the 512-weight capacitor is switched to REF –. If the voltage at the summing node is less than the trip point of the threshold detector, a bit 1 is placed in the register and the 512-weight capacitor remains connected to REF + through the remainder of the successive-approximation process. The process is repeated for the 256-weight capacitor, the 128-weight capacitor, and so forth down the line until all bits are counted.

With each step of the successive-approximation process, the initial charge is redistributed among the capacitors. The conversion process relies on charge redistribution to count and weigh the bits from MSB to LSB.

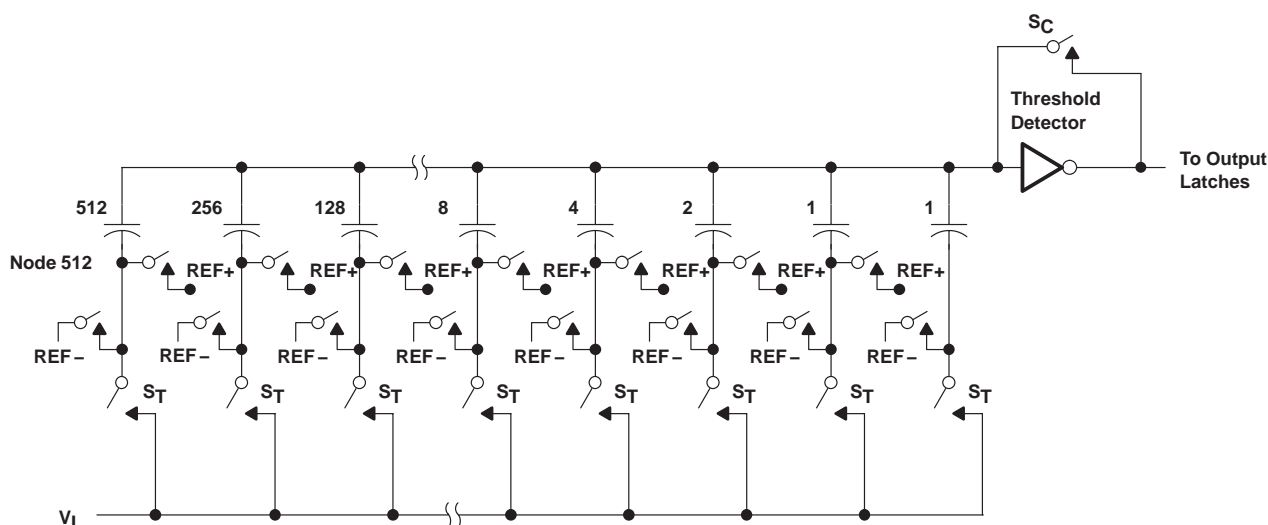


Figure 1. Simplified Model of the Successive-Approximation System

extended sampling, asynchronous start of sampling: $\overline{\text{CSTART}}$ operation

The extended sampling mode of operation programs the acquisition time (t_{ACQ}) of the sample-and-hold circuit. This allows the analog inputs of the device to be directly interfaced to a wide range of input source impedances. The extended sampling mode consumes higher power depending on the duration of the sampling period chosen.

$\overline{\text{CSTART}}$ controls the sampling period and starts the conversion. The falling edge of $\overline{\text{CSTART}}$ initiates the sampling period of a preset channel. The low time of $\overline{\text{CSTART}}$ controls the acquisition time of the input sample-and-hold circuit. The sample is held on the rising edge of $\overline{\text{CSTART}}$. Asserting $\overline{\text{CSTART}}$ causes the converter to perform a new sample of the signal on the preset valid MUX channel (one of the eight) and discard the current conversion result ready for output. Sampling continues as long as $\overline{\text{CSTART}}$ is active (negative). The rising edge of $\overline{\text{CSTART}}$ ends the sampling cycle. The conversion cycle starts two internal system clocks after the rising edge of $\overline{\text{CSTART}}$.

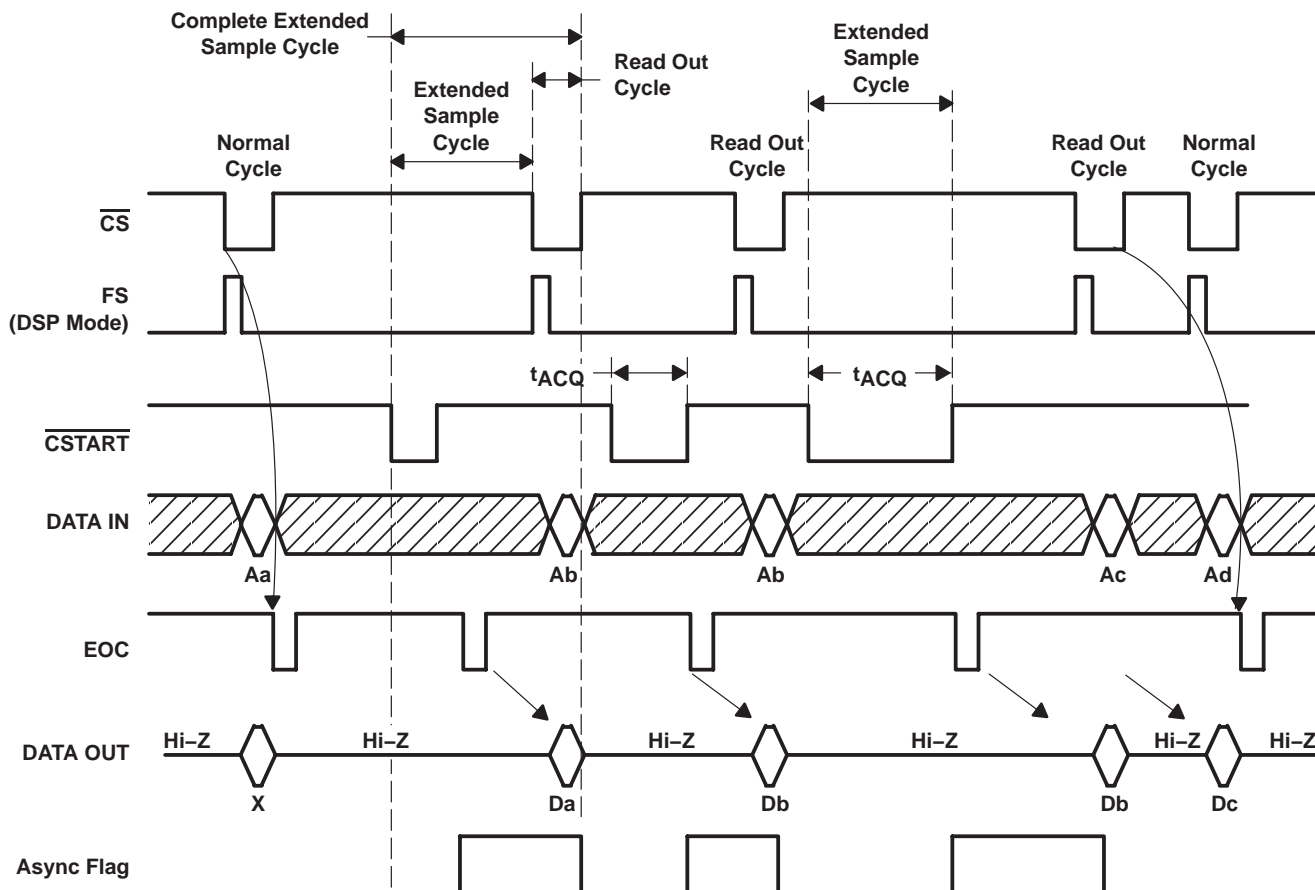
Once the conversion is complete, the processor can initiate a normal I/O cycle to read the conversion result and set the MUX address for the next conversion. Since the internal flag AsyncFlag is set high, this flag setting indicates the cycle is an output cycle, so no conversion is performed during the cycle. The internal state machine tests the AsyncFlag on the falling edge of $\overline{\text{CS}}$. AsyncFlag is set high at the rising edge of $\overline{\text{CSTART}}$, and it is reset low at the rising edge of each $\overline{\text{CS}}$. A conversion cycle follows a sampling cycle only if AsyncFlag is tested as low at the falling edge of $\overline{\text{CS}}$. As shown in Figure 2, an asynchronous I/O cycle can be removed by two consecutive normal I/O cycles.

Table 4. TLV1548 Hardware Configuration for Different Operating Modes

| OPERATING MODES | $\overline{\text{CS}}$ | $\overline{\text{CSTART}}$ | AsyncFlag at $\overline{\text{CS}}\downarrow$ | ACTION |
|----------------------------|------------------------|----------------------------|---|---|
| Normal sampling | Low | High | Low | Fixed 6 I/O CLK sampling, synchronous conversion follows |
| Normal I/O (read out only) | Low | High | High | No sampling, no conversion |
| Extended sampling | High | Low | N/A | Flexible sampling period controlled by $\overline{\text{CSTART}}$, asynchronous conversion follows |

TLV1548-EP LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003



NOTES: A. Aa = Address for input channel a.
B. Da = Conversion result from channel a.

Figure 2. Extended Sampling Operation

reference voltage inputs

There are two reference inputs used with the TLV1548, REF+ and REF-. These voltage values establish the upper and lower limits of the analog inputs to produce a full-scale and zero-scale reading respectively. The values of REF+, REF-, and the analog input should not exceed the positive supply or be lower than GND consistent with the specified absolute maximum ratings. The digital output is at full scale when the input signal is equal to or higher than REF+ and is at zero when the input signal is equal to or lower than REF-.

programmable conversion rate

The TLV1548 offers two conversion rates to maximize battery life when high-speed operation is not necessary. The conversion rate is programmable. Once the conversion rate has been selected, it takes effect immediately in the same cycle and stays at the same rate until the other rate is chosen. The conversion rate should be set at power up. Activation and deactivation of the power-down state (digital logic active) has no effect on the preset conversion rate.

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

Table 5. Conversion Rate and Power Consumption Selection

| CONVERSION RATE | CONVERSION TIME, t_{conv} | AVAILABLE V_{CC} RANGE | INPUT DATA | TYPICAL SUPPLY CURRENT, I_{CC} | | |
|-----------------------|-----------------------------|--------------------------|------------|----------------------------------|------------|---------------|
| | | | | OPERATING | | POWER DOWN |
| Fast conversion speed | 7 μ s typ | 5.5 V to 3.3 V | 9h | 0.6 mA typ | 1.5 mA max | 1 μ A typ |
| Slow conversion speed | 15 μ s typ | 5.5 V to 2.7 V | Ah | 0.4 mA typ | 1 mA max | 1 μ A typ |

programmable power-down state

The device is put into the power-down state by writing 8h to DATA IN. The power-up state is restored during the next active access by pulling \overline{CS} low. The conversion rate selected before the device is put into the power-down state is not affected by the power-down mode. Power-down can be used to achieve even lower power consumption. This is because the sustaining power (when not converting) is only 1.3 mA maximum and standby power is only 1 μ A maximum. (By averaging out the power consumption can be much lower than the 1 mA peak when the conversion throughput is lower.)

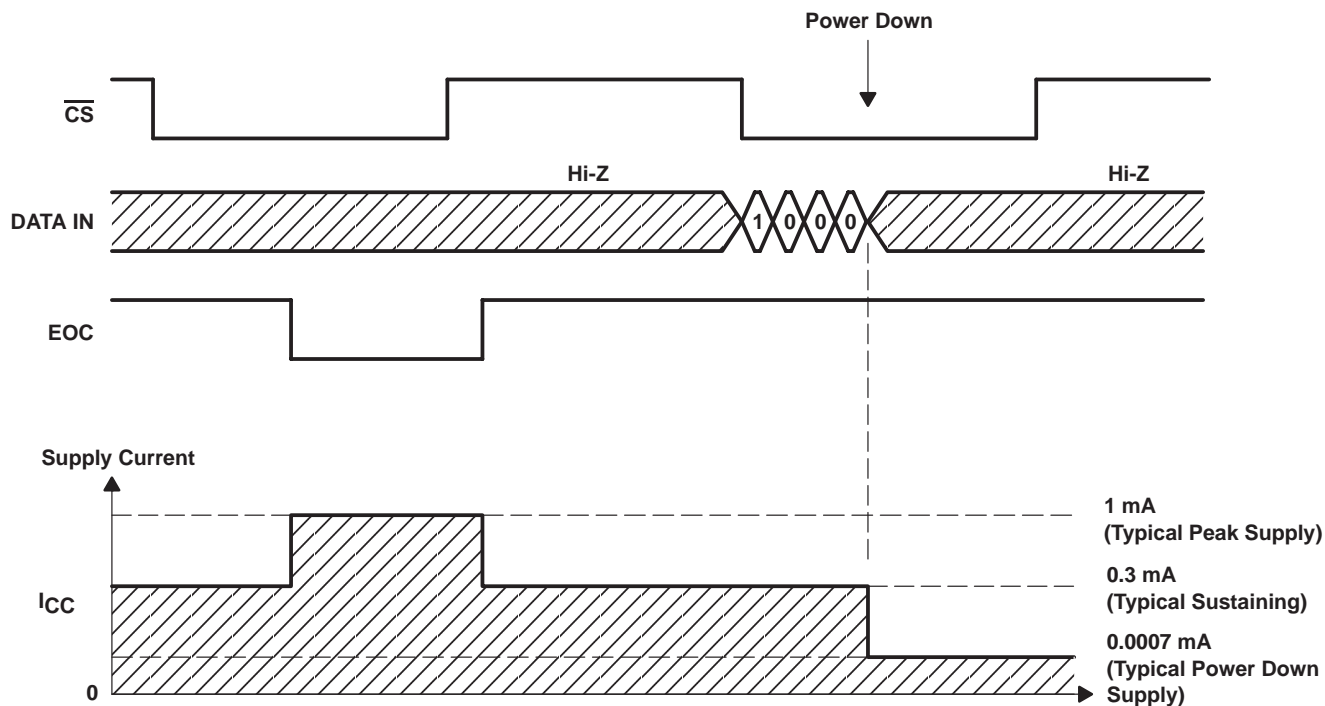


Figure 3. Typical Supply Current During Conversion/Power Down

power up and initialization

After power up, if operating in DSP mode, \overline{CS} and FS must be taken from high to low to begin an I/O cycle. EOC is initially high, and the input data register is set to all zeroes. The content of the output data register is random, and the first conversion result should be ignored. For initialization during operation, \overline{CS} is taken high and returned low to begin the next I/O cycle. The first conversion after the device has returned from the power-down state can be invalid and should be disregarded.

When power is first applied to the device, the conversion rate must be programmed, and the internal Async Flag must be taken low once. The rising edge of \overline{CS} of the same cycle then takes Async Flag low.

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

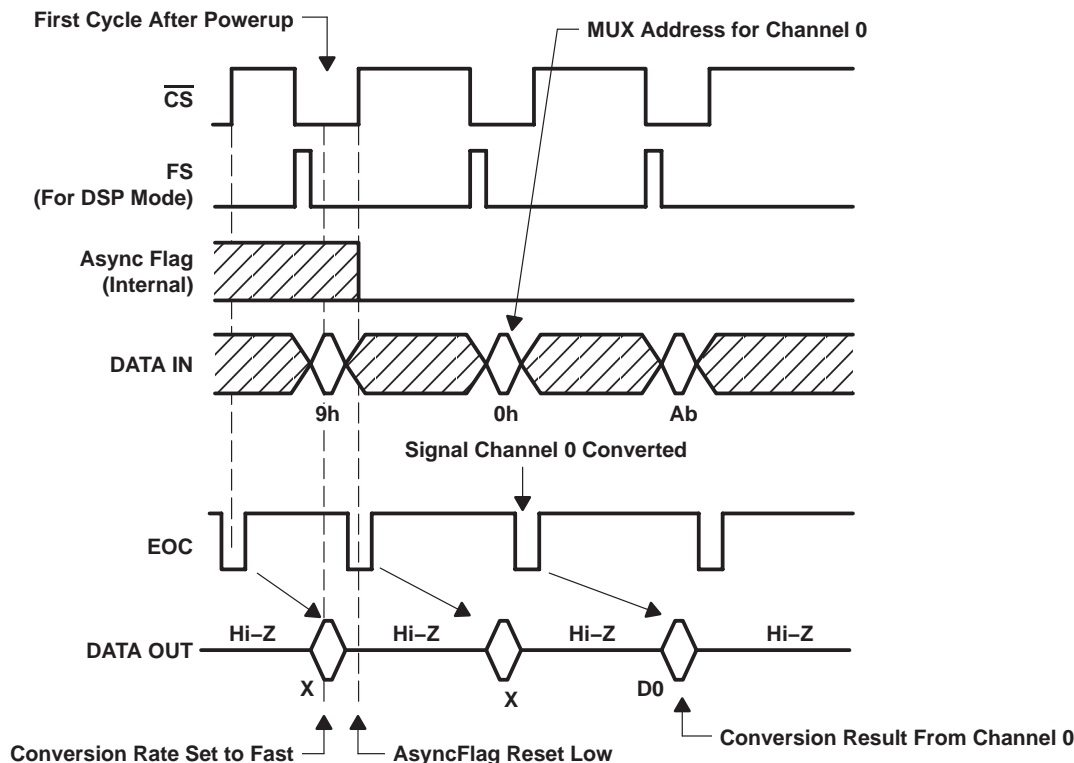


Figure 4. Power Up Initialization

input clock inversion – $\overline{INV CLK}$

The input data register uses I/O CLK as the source of the sampling clock. This clock can be inverted to provide more setup time. $\overline{INV CLK}$ can invert the clock. When $\overline{INV CLK}$ is grounded, the input clock for the input data register is inverted. This allows an additional one-half I/O CLK period for the input data setup time. This is useful for some serial interfaces. When the input sampling clock is inverted, the output data changes at the same time that the input data is sampled.

Table 6. Function of $\overline{INV CLK}$

| CONDITION CLOCK | | I/O CLK ACTIVE EDGE | |
|----------------------|----------------------------------|------------------------|-----------------------|
| $\overline{INV CLK}$ | FS at $\overline{CS} \downarrow$ | OUTPUT DATA CHANGES ON | INPUT DATA SAMPLED ON |
| High | High (MP [†] mode) | ↓ | ↑ |
| High | Low (DSP [‡] mode) | ↑ | ↓ |
| Low | High (MP [†] mode) | ↓ | ↓ |
| Low | Low (DSP [‡] mode) | ↑ | ↑ |

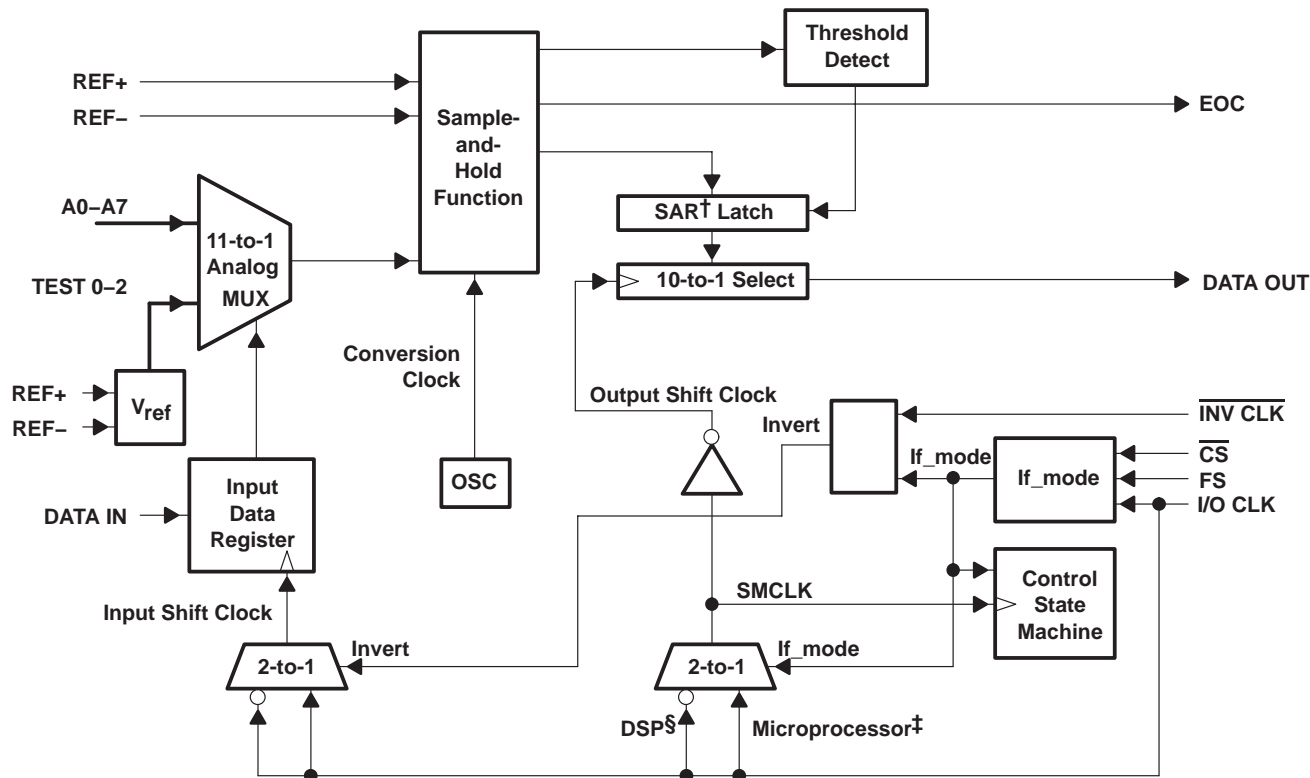
[†] MP = microprocessor mode

[‡] DSP = digital signal processor mode

TLV1548-EP

LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003



† Successive approximation register
 ‡ If_mode = 1, microprocessor interface mode
 § If_mode = 0, DSP interface mode

Figure 5. Clock Scheme

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|--|----------------------------|
| Supply voltage range, V_{CC} (see Note 1) | -0.5 V to 6.5 V |
| Input voltage range, V_I (any input) | -0.3 V to $V_{CC} + 0.3$ V |
| Output voltage range, V_O | -0.3 V to $V_{CC} + 0.3$ V |
| Positive reference voltage, V_{ref+} | $V_{CC} + 0.1$ V |
| Negative reference voltage, V_{ref-} | -0.1 V |
| Peak input current, I_I (any input) | ± 20 mA |
| Peak total input current (all inputs) | -30 mA |
| Operating free-air temperature range, T_A : TLV1548Q | -40°C to 125°C |
| Storage temperature range, T_{stg} | -65°C to 150°C |
| Thermal resistance, Junction-to-Air, θ_{JA} | 114.2°C/W |
| Lead temperature 1,6 mm (1/16 inch) from the case for 10 seconds | 260°C |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND with REF- and GND wired together (unless otherwise noted).

TLV1548-EP

LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

recommended operating conditions

| | MIN | NOM | MAX | UNIT |
|--|---|----------|----------------|--------------------|
| Supply voltage, V_{CC} | 2.7 | | 5.5 | V |
| Positive reference voltage, V_{ref+} (see Note 2) | | V_{CC} | | V |
| Negative reference voltage, V_{ref-} (see Note 2) | | 0 | | V |
| Differential reference voltage, $V_{ref+} - V_{ref-}$ (see Note 2) | 2.5 | V_{CC} | $V_{CC} + 0.2$ | V |
| Analog input voltage, V_I (analog) (see Note 2) | 0 | | V_{CC} | V |
| High-level control input voltage, V_{IH} | 2.1 | | | V |
| Low-level control input voltage, V_{IL} | | | 0.6 | V |
| Setup time, input data bits valid before I/O CLK \uparrow , $t_{su(A)}$ (see Figure 9) | 100 | | | ns |
| Hold time, input data bits valid after I/O CLK \downarrow , $t_h(A)$ (see Figure 9) | 5 | 30 | | ns |
| Setup time, $\overline{CS}\downarrow$ to I/O CLK \uparrow , $t_{su(CS)}$ | See Figure 10 and Note 3 | | 5 30 | ns |
| Hold time, I/O CLK \downarrow to $\overline{CS}\uparrow$, $t_h(CS)$ | See Figure 10 | | 65 | ns |
| Pulse duration, FS high, $t_{wH}(FS)$ | See Figure 14 | | 1 | I/O CLK periods |
| Pulse duration, \overline{CSTART} , $t_w(CSTART)$ | Source impedance $\leq 1\text{ k}\Omega$, $V_{CC} = 5.5\text{ V}$, See Figure 15 | | 0.84 | μs |
| Setup time, $\overline{CS}\uparrow$ to $\overline{CSTART}\downarrow$, $t_{su(CSTART)}$ | See Figure 15 | | 10 | ns |
| Clock frequency at I/O CLK, f_{CLK} | $V_{CC} = 5.5\text{ V}$ | | 0.1 6 10 | MHz |
| | $V_{CC} = 2.7\text{ V}$ | | 0.1 2 2.81 | |
| Pulse duration, I/O CLK high, $t_{wH}(I/O)$ | $V_{CC} = 5.5\text{ V}$ | | 50 | ns |
| | $V_{CC} = 2.7\text{ V}$ | | 100 | |
| Pulse duration, I/O CLK low, $t_{wL}(I/O)$ | $V_{CC} = 5.5\text{ V}$ | | 50 | ns |
| | $V_{CC} = 2.7\text{ V}$ | | 100 | |
| Operating free-air temperature, T_A | TLV1548Q | | -40 125 | $^{\circ}\text{C}$ |
| Junction temperature, T_J | TLV1548Q | | 150 | $^{\circ}\text{C}$ |

NOTES: 2. Analog input voltages greater than the voltage applied to REF+ convert as all ones (1111111111), while input voltages less than the voltage applied to REF- convert as all zeros (0000000000). The device is functional with reference ($V_{ref+} - V_{ref-}$) down to 1 V; however, the electrical specifications are no longer applicable.

3. To minimize errors caused by noise at $\overline{CS}\downarrow$, the internal circuitry waits for a setup time after $\overline{CS}\downarrow$ before responding to control input signals. No attempt should be made to clock in an input dat until the minimum \overline{CS} setup time has elapsed.



TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

**electrical characteristics over recommended operating free-air temperature range,
 $V_{CC} = V_{ref+} = 2.7\text{ V to }5.5\text{ V}$, I/O CLK frequency = 2.2 MHz (unless otherwise noted)**

| PARAMETER | | TEST CONDITIONS | | MIN | TYP† | MAX | UNIT |
|---------------------|--|--|----------------------------------|-----|--------|------|------|
| V _{OH} | High-level output voltage | V _{CC} = 5.5 V, | I _{OH} = -0.2 mA | 2.4 | | | V |
| | | V _{CC} = 2.7 V, | I _{OH} = -20 μA | 2.4 | | | |
| V _{OL} | Low-level output voltage | V _{CC} = 5.5 V, | I _{OL} = 0.8 mA | | | 0.4 | V |
| | | V _{CC} = 2.7 V, | I _{OL} = 20 μA | | | 0.1 | |
| I _{OZ} | High-impedance output current | V _O = V _{CC} , | $\overline{CS} = V_{CC}$ | | 1 | 2.5 | μA |
| | | V _O = 0, | $\overline{CS} = V_{CC}$ | | -1 | -2.5 | |
| I _{IH} | High-level input current | V _I = V _{CC} | | | 0.005 | 2.5 | μA |
| I _{IL} | Low-level input current | V _I = 0 | | | -0.005 | 2.5 | μA |
| I _{CC} | Operating supply current | Conversion speed = fast, For all digital inputs, 0 ≤ V _I ≤ 0.3 V or V _I ≥ V _{CC} - 0.3 V | V _{CC} = 3.3 V to 5.5 V | | 0.6 | 1.5 | mA |
| | | | V _{CC} = 3.3 V to 5.5 V | | 0.4 | 1 | |
| | | Conversion speed = slow, For all digital inputs, 0 ≤ V _I ≤ 0.3 V or V _I ≥ V _{CC} - 0.3 V | V _{CC} = 2.7 V to 3.3 V | | 0.35 | 0.75 | |
| I _{CC(ES)} | Extended sampling mode operating current | V _{CC} = 3.3 V to 5.5 V | | | 1.5 | | mA |
| | | V _{CC} = 2.7 V to 3.3 V | | | 1 | | mA |
| I _{CC(ST)} | Sustaining supply current | Conversion speed = slow, For all digital inputs, 0 ≤ V _I ≤ 0.3 V or V _I ≥ V _{CC} - 0.3 V | V _{CC} = 2.7 V to 3.3 V | | 0.3 | | mA |
| I _{CC(PD)} | Power-down supply current | For all digital inputs, 0 ≤ V _I ≤ 0.3 V or V _I ≥ V _{CC} - 0.3 V | | | 1 | 25 | μA |
| I _{lkg} | Selected channel leakage current | Selected channel at V _{CC} , unselected channel at 0 V | | | | 1 | μA |
| | | Selected channel at 0 V, unselected channel at V _{CC} | | | | -1 | μA |
| | Maximum static analog reference current into REF+ | V _{ref+} = V _{CC} = 5.5 V, | V _{ref-} = GND | | | 1 | μA |
| C _i | Input capacitance, analog inputs | | | | 20 | 55 | pF |
| | Input capacitance, control inputs | | | | 20 | 15 | |
| Z _i | Input multiplexer on resistance | V _{CC} = 4.5 V | | | | 1 | kΩ |
| | | V _{CC} = 2.7 V | | | | 5 | |

† All typical values are at V_{CC} = 5 V, T_A = 25°C.



TLV1548-EP

LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

operating characteristics over recommended operating free-air temperature range,
 $V_{CC} = V_{ref+} = 2.7\text{ V to }5.5\text{ V}$, I/O CLK frequency = 2.2 MHz (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP† | MAX | UNIT | |
|--|--|---------------------------------------|--|------|-------------------|-----------------|----|
| E_L | Linearity error (see Note 6) | | | ±0.5 | ±1 | LSB | |
| E_D | Differential linearity error | See Note 2 | | ±0.5 | ±1 | LSB | |
| E_O | Offset error (see Note 7) | See Note 2 | | | ±1.5 | LSB | |
| E_G | Gain error (see Note 7) | See Note 2 | | | ±1 | LSB | |
| E_T | Total unadjusted error (see Note 8) | | | | ±1.75 | LSB | |
| Self-test output code (see Table 3 and Note 9) | | DATA IN = 1011 | | 512 | | | |
| | | DATA IN = 1100 | | 0 | | | |
| | | DATA IN = 1101 | | 1023 | | | |
| t_{conv} | Conversion time | Fast conversion speed | See Figures 16 through 19 | | 7 | 10 | μs |
| | | Slow conversion speed | | | 15 | 25 | μs |
| t_c | Total cycle time (access, sample, conversion and EOC↑ to CS↓ delay) | Fast conversion speed | See Figures 15 through 19 and Notes 10, 11, 12 | | 10.1 + 10 I/O CLK | | μs |
| | | Slow conversion speed | See Figures 15 through 19 and Notes 10 and 12 | | 40.1 + 10 I/O CLK | | |
| t_{acq} | Channel acquisition time (sample) | See Figures 15 through 18 and Note 10 | | | 6 | I/O CLK periods | |
| t_v | Valid time, DATA OUT remains valid after I/O CLK↓ | See Figure 11 | | 20 | | ns | |
| $t_{d1}(FS)$ | Delay time, I/O CLK high to FS high | See Figure 14 | 5 | 30 | 50 | ns | |
| $t_{d2}(FS)$ | Delay time, I/O CLK high to FS low | See Figure 14 | 10 | 30 | 60 | ns | |
| $t_d(EOC↑ - CS↓)$ | Delay time, EOC↑ to CS low | See Figure 15 and Note 5 | 100 | | | ns | |
| $t_d(CS↓ - FS↑)$ | Delay time, CS↓ to FS↑ | See Figures 12 and 18 | 1 | | 7 | I/O CLK periods | |
| $t_d(I/O - CS)$ | Delay time, 10th I/O CLK low to CS low to abort conversion (see Note 13) | See Figure 10 | | | 1.1 | μs | |

† All typical values are at $T_A = 25^\circ\text{C}$.

NOTES: 2. Analog input voltages greater than that applied to REF+ convert as all ones (111111111), while input voltages less than that applied to REF- convert as all zeros (000000000). The device is functional with reference down to 1 V ($V_{ref+} - V_{ref-} - 1$); however, the electrical specifications are no longer applicable.

5. For all operating modes.
6. Linearity error is the maximum deviation from the best straight line through the A/D transfer characteristics.
7. Zero error is the difference between 000000000 and the converted output for zero input voltage. Full-scale error is the difference between 111111111 and the converted output for full-scale input voltage.
8. Total unadjusted error comprises linearity, zero-scale, and full-scale errors.
9. Both the input data and the output codes are expressed in positive logic.
10. I/O CLK period = 1/(I/O CLK frequency) (see Figure 8).
11. For 3.3 V to 5.5 V only
12. For microprocessor mode
13. Any transitions of CS are recognized as valid only when the level is maintained for a setup time after the transition.



TLV1548-EP

LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

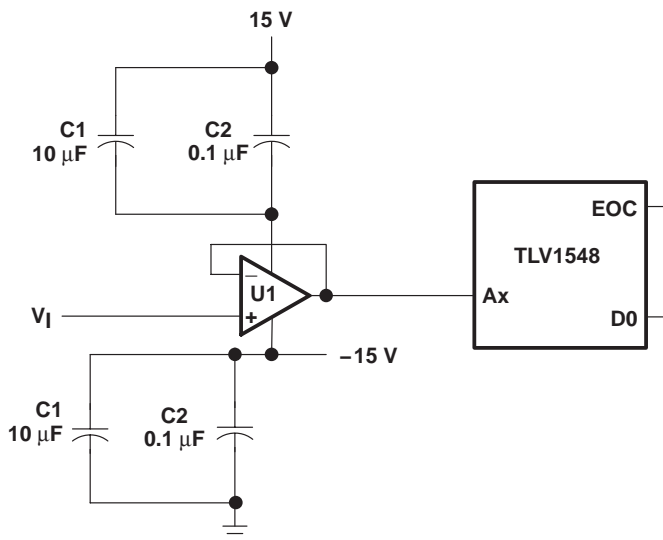
SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

operating characteristics over recommended operating free-air temperature range,
 $V_{CC} = V_{ref+} = 2.7\text{ V to }5.5\text{ V}$, I/O CLK frequency = 2.2 MHz (unless otherwise noted) (continued)

| PARAMETER | TEST CONDITIONS | MIN | TYP† | MAX | UNIT |
|------------------------|---|-----|------|-----|---------------|
| $t_d(\text{I/O-DATA})$ | Delay time, I/O CLK low to DATA OUT valid | | | 60 | ns |
| $t_d(\text{I/O-EOC})$ | Delay time, 10th I/O CLK↓ to EOC low | | 70 | 240 | ns |
| t_{PZH}, t_{PZL} | Enable time, \overline{CS} low to DATA OUT valid (MSB driven) | | 0.7 | 1.3 | μs |
| t_{PHZ}, t_{PLZ} | Disable time, \overline{CS} high to DATA OUT invalid (high impedance) | | 70 | 150 | ns |
| $t_f(\text{EOC})$ | Fall time, EOC | | 15 | 50 | ns |
| $t_r(\text{bus})$ | Rise time, output data bus at 2.2 MHz I/O CLK | | 50 | 250 | ns |
| $t_f(\text{bus})$ | Fall time, output data bus at 2.2 MHz I/O CLK | | 50 | 250 | ns |

† All typical values are at $T_A = 25^\circ\text{C}$.

PARAMETER MEASUREMENT INFORMATION



| LOCATION | DESCRIPTION | PART NUMBER |
|----------|--|----------------------------------|
| U1 | OP27 | — |
| C1 | 10- μF 35-V tantalum capacitor | — |
| C2 | 0.1- μF ceramic NPO SMD capacitor | AVX 12105C104KA105 or equivalent |

Figure 6. Analog Input Buffer to Analog Inputs

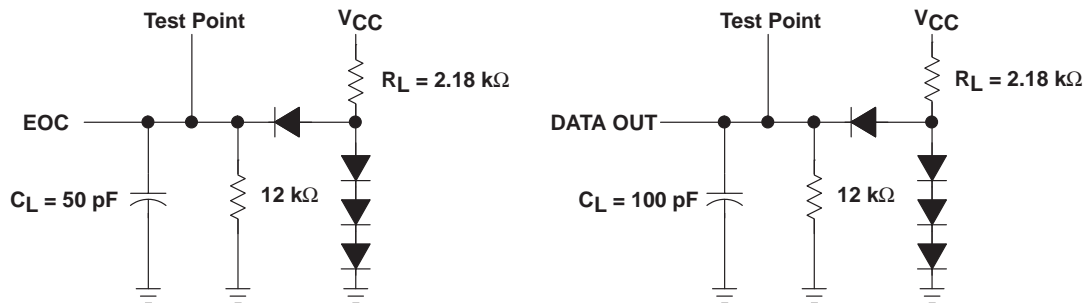


Figure 7. Load Circuits

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

PARAMETER MEASUREMENT INFORMATION

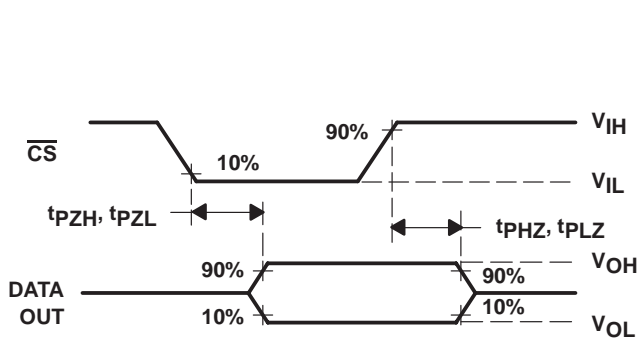


Figure 8. DATA OUT to Hi-Z Voltage Waveforms

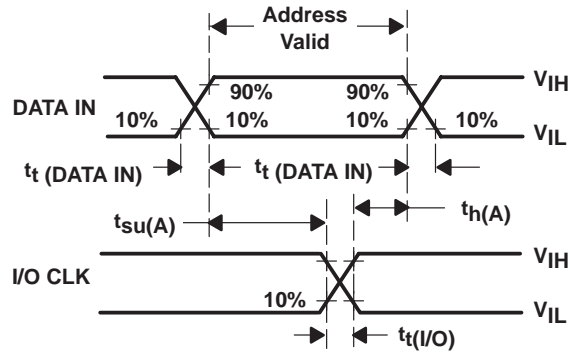


Figure 9. DATA IN Setup Voltage Waveforms

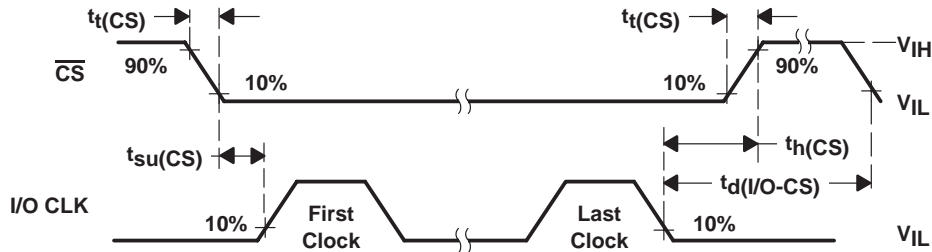


Figure 10. CS and I/O CLK Voltage Waveforms

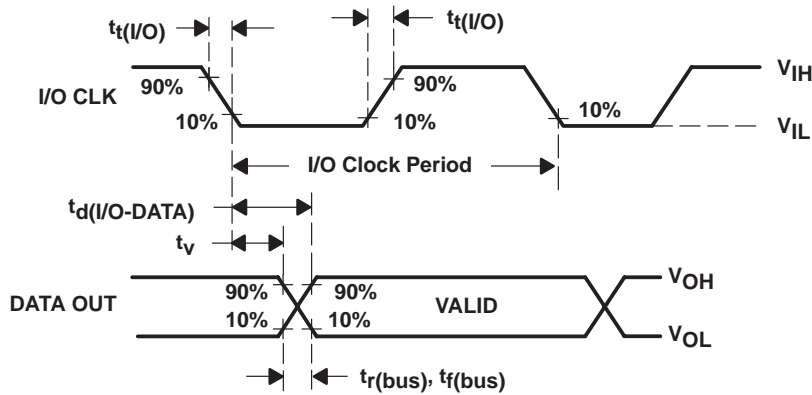


Figure 11. DATA OUT and I/O CLK Voltage Waveforms

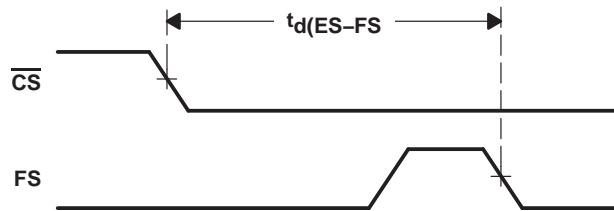


Figure 12. CS Low to FS Low

PARAMETER MEASUREMENT INFORMATION

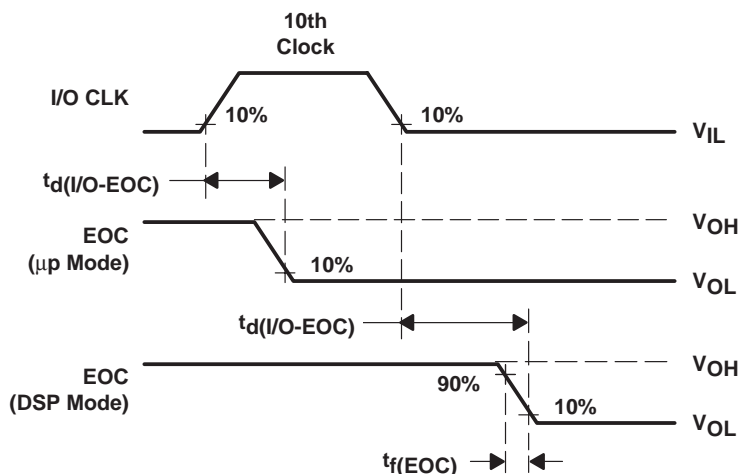


Figure 13. I/O CLK and EOC Voltage Waveforms

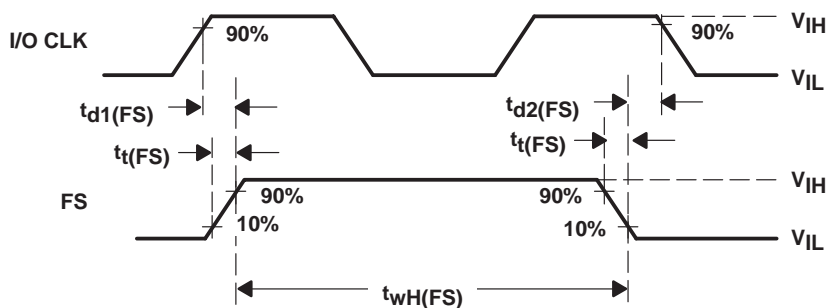


Figure 14. FS and I/O CLK Voltage Waveforms

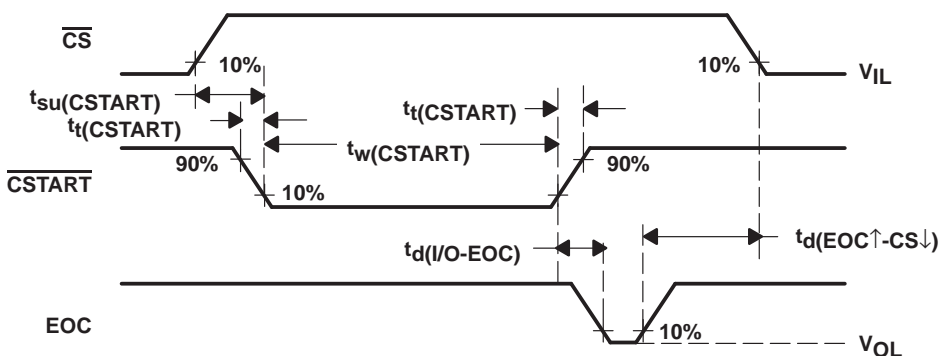
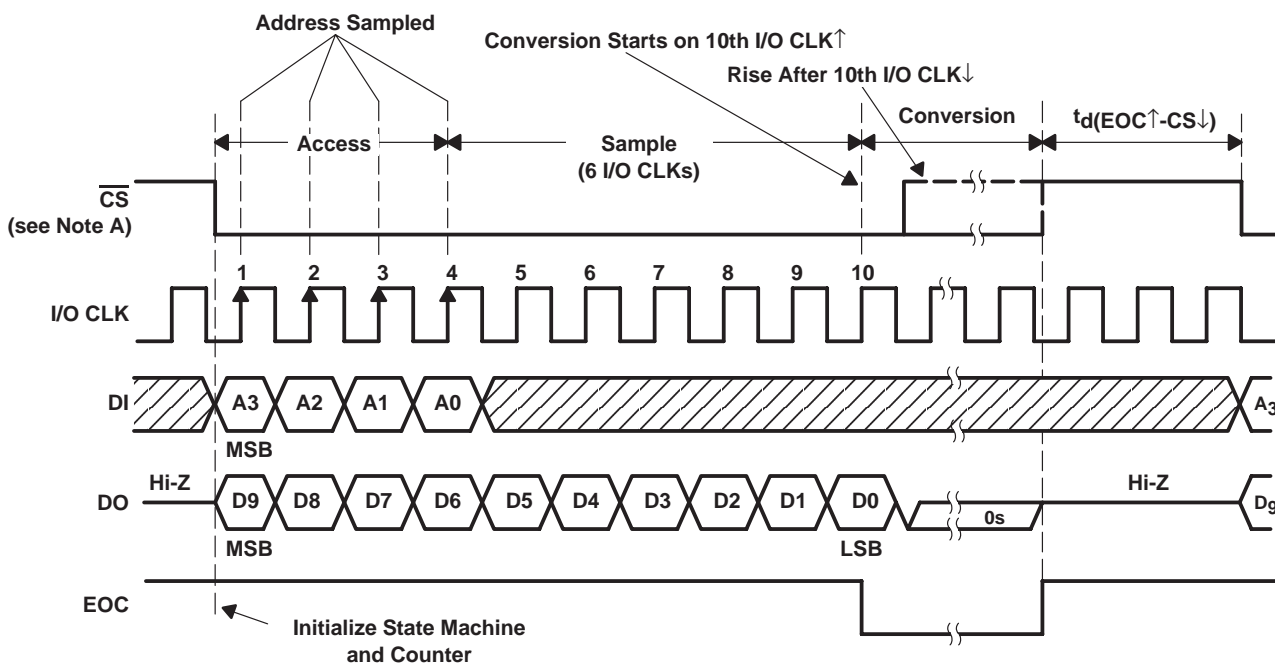


Figure 15. CSTART and CS Waveforms

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

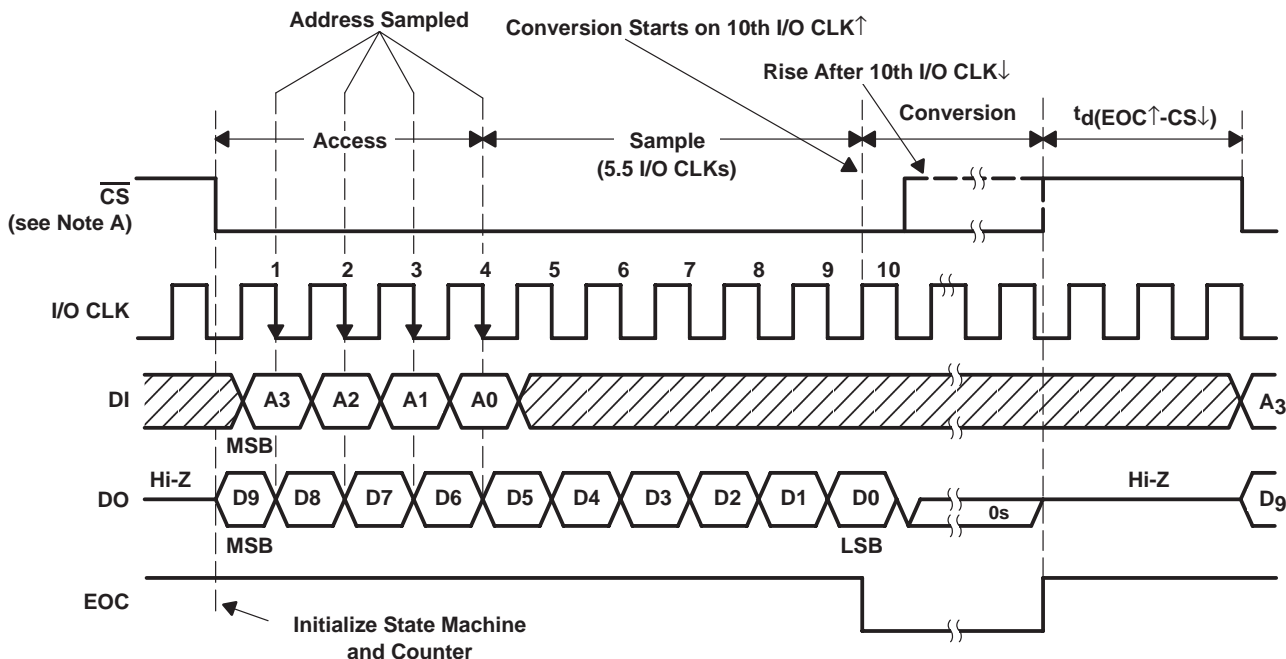
SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

PARAMETER MEASUREMENT INFORMATION



NOTE A: To minimize errors caused by noise at \overline{CS} , the internal circuitry waits for a setup time after $\overline{CS}\downarrow$ before responding to control input signals. No attempt should be made to clock in input data until the minimum \overline{CS} setup time elapses.

Figure 16. Microprocessor Interface Timing (Normal Sample Mode, $\overline{INV CLK} = \text{High}$)



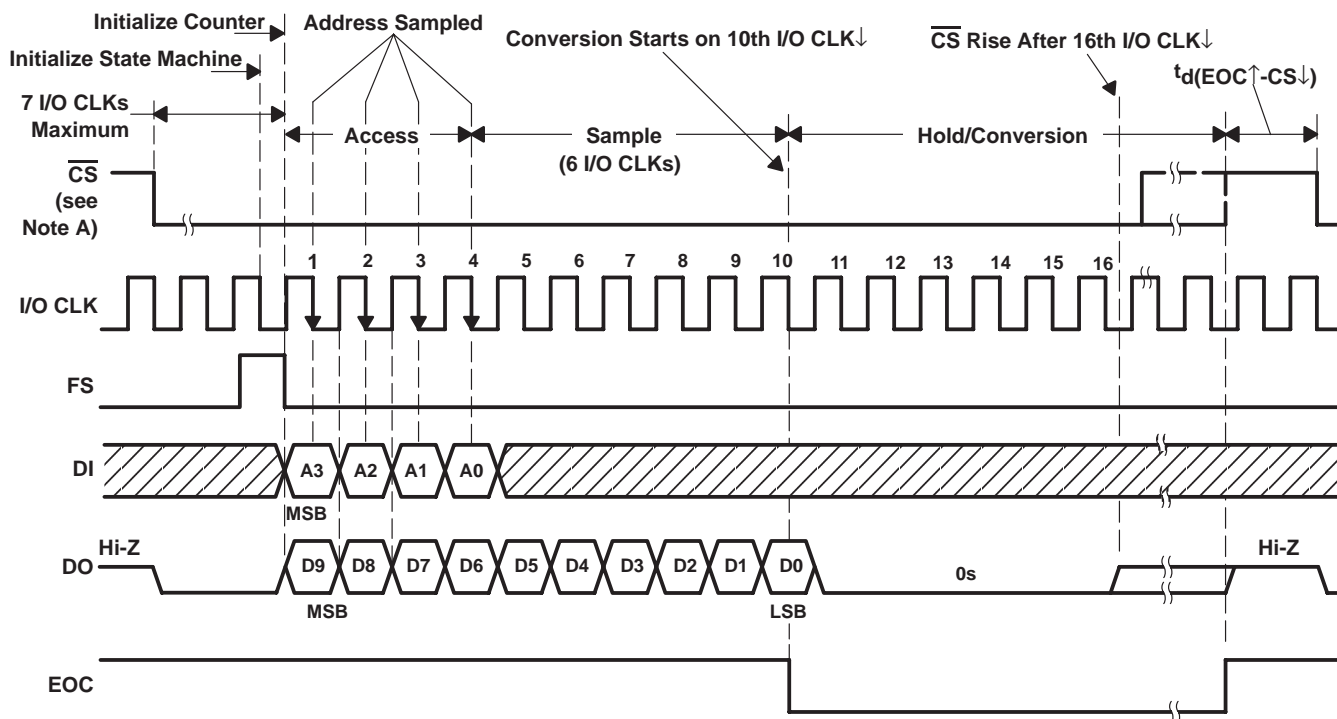
NOTE A: To minimize errors caused by noise at \overline{CS} , the internal circuitry waits for a setup time after $\overline{CS}\downarrow$ before responding to control input signals. No attempt should be made to clock in input data until the minimum \overline{CS} setup time has elapsed.

Figure 17. Microprocessor Interface Timing (Normal Sample Mode, $\overline{INV CLK} = \text{Low}$)

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

PARAMETER MEASUREMENT INFORMATION



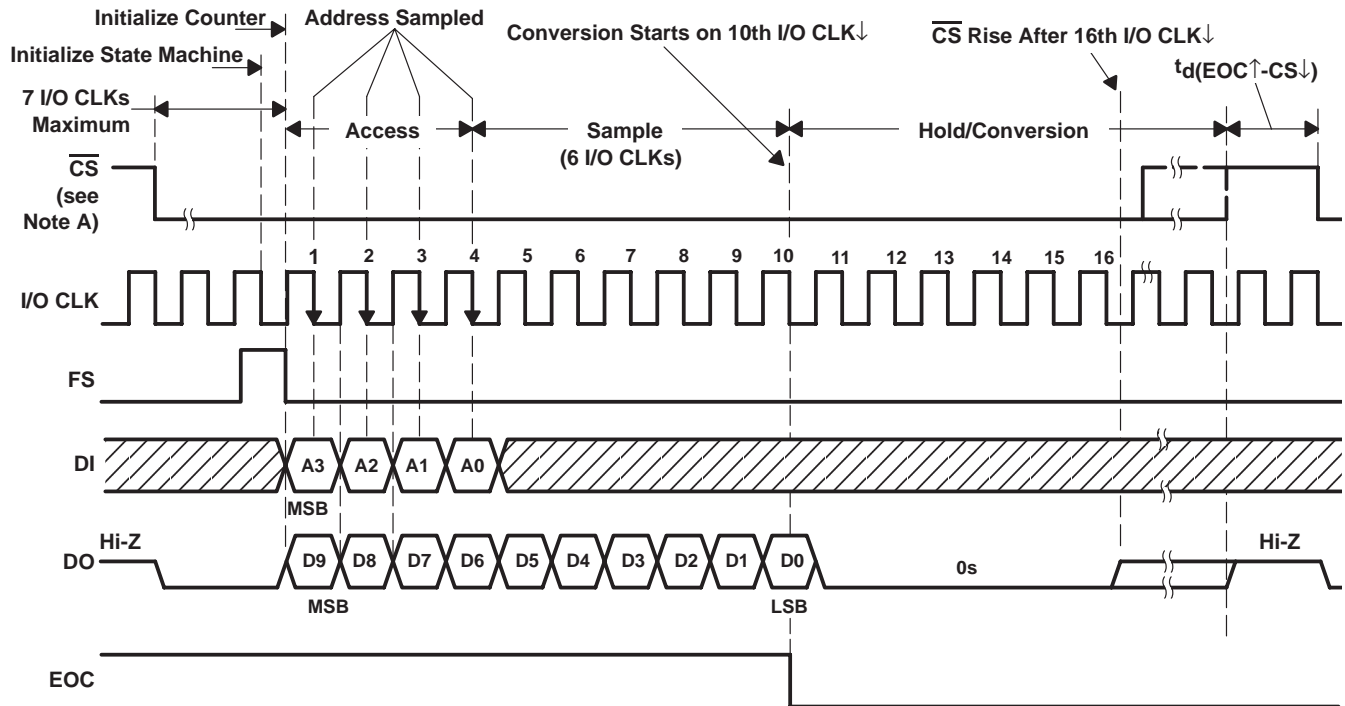
NOTE A: To minimize errors caused by noise at $\overline{\text{CS}}$, the internal circuitry waits for a setup time after $\overline{\text{CS}}\downarrow$ before responding to control input signals. No attempt should be made to clock in input data until the minimum $\overline{\text{CS}}$ setup time elapses.

Figure 18. DSP Interface Timing (16-Clock Transfer, Normal Sample Mode, $\overline{\text{INV CLK}} = \text{High}$)

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

PARAMETER MEASUREMENT INFORMATION



NOTE A: To minimize errors caused by noise at \overline{CS} , the internal circuitry waits for a setup time after $\overline{CS}\downarrow$ before responding to control input signals. No attempt should be made to clock in input data until the minimum \overline{CS} setup time elapses.

Figure 19. DSP Interface Timing (16-Clock Transfer, Normal Sample Mode, $\overline{INV\ CLK} = \text{Low}$)

TYPICAL CHARACTERISTICS

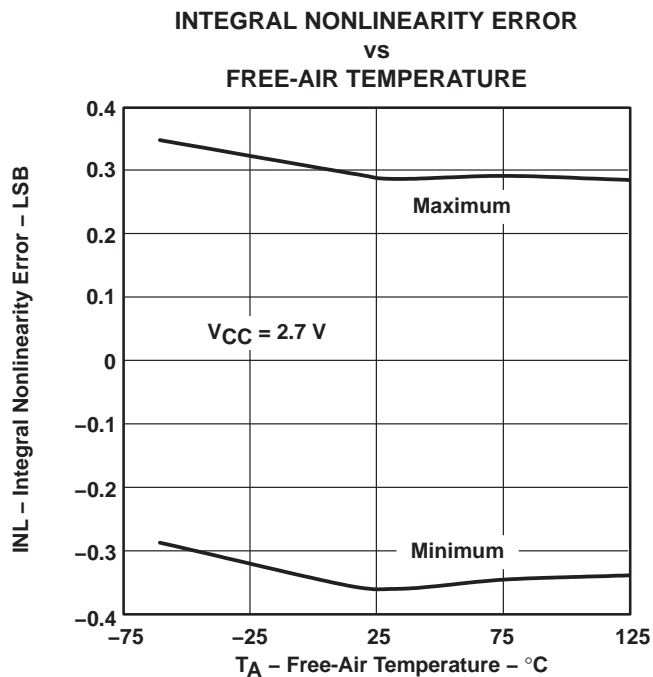


Figure 20

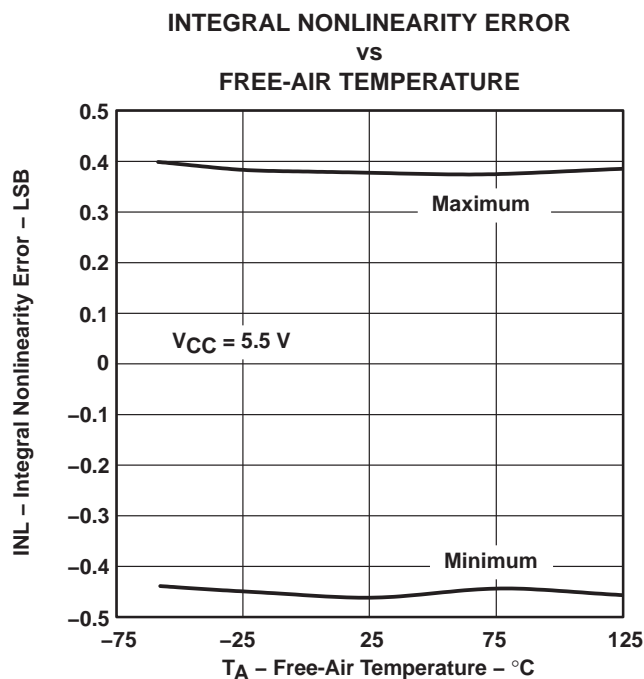


Figure 21

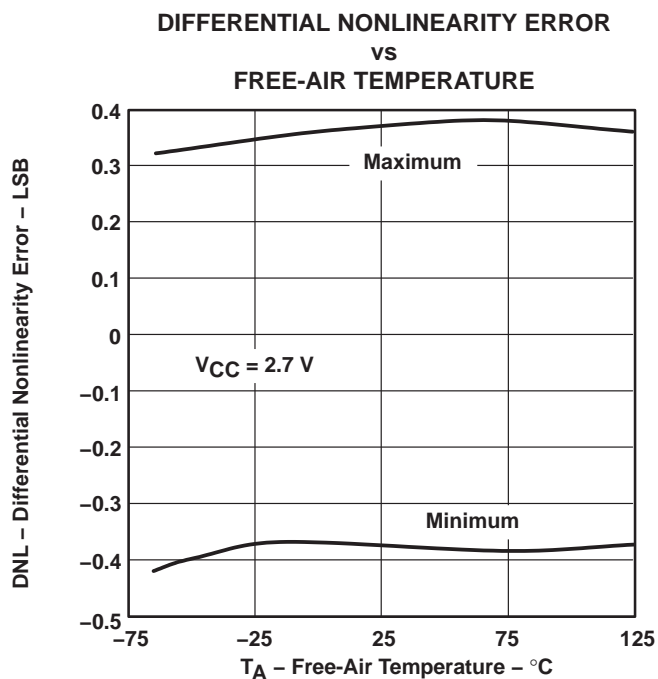


Figure 22

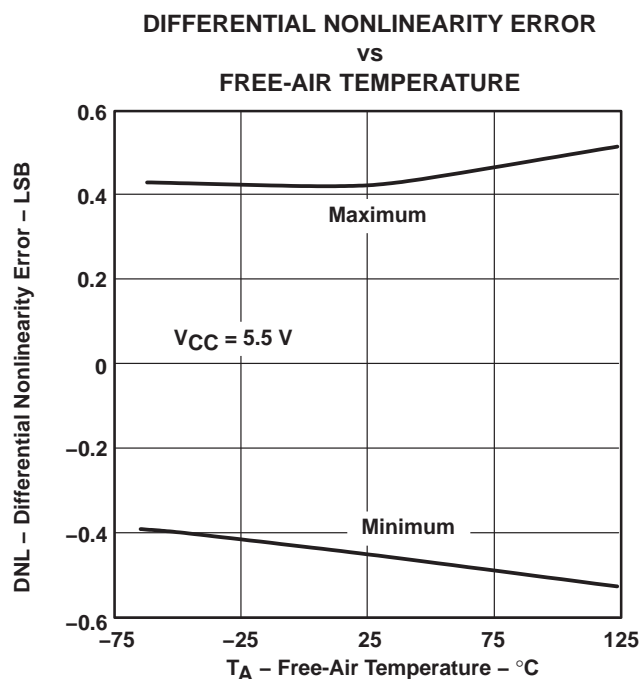


Figure 23

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

TYPICAL CHARACTERISTICS

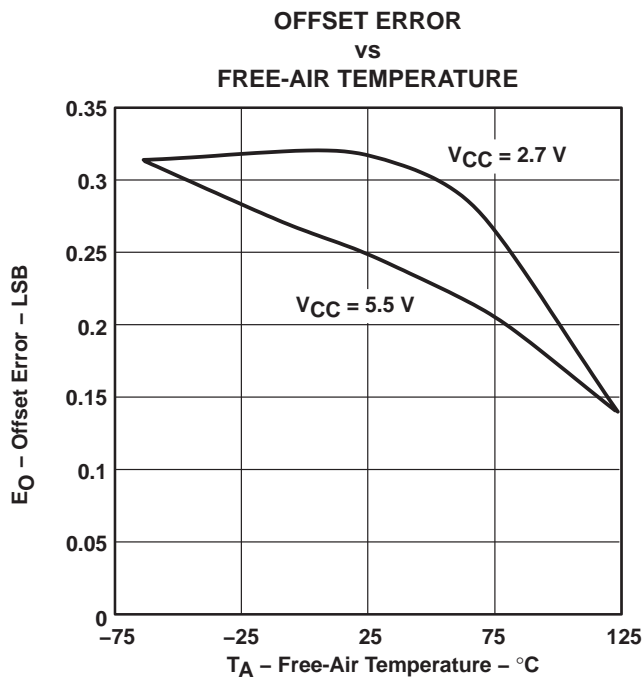


Figure 24

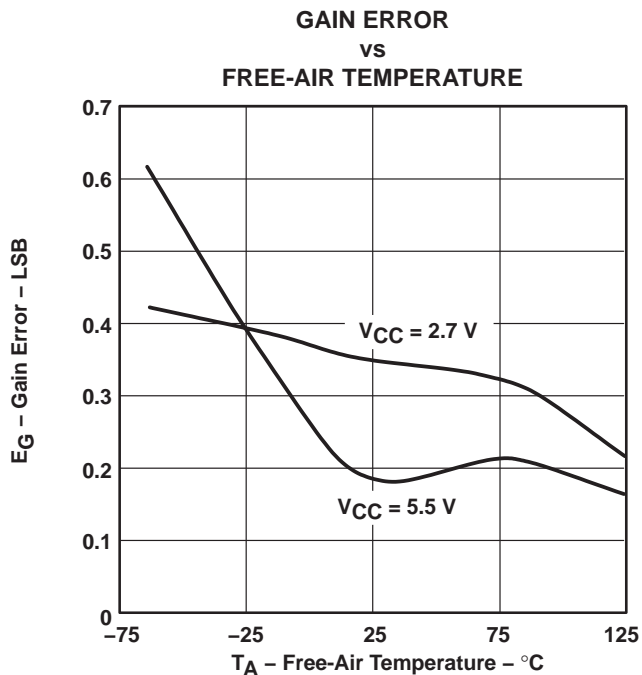


Figure 25

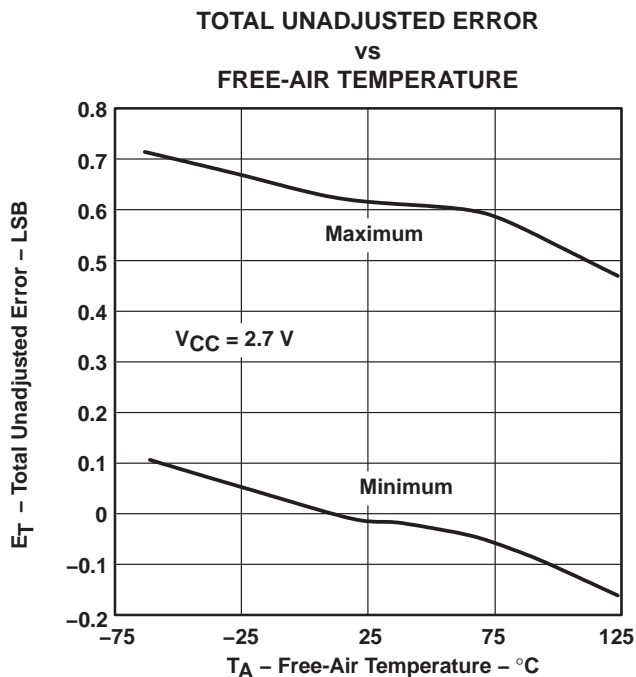


Figure 26

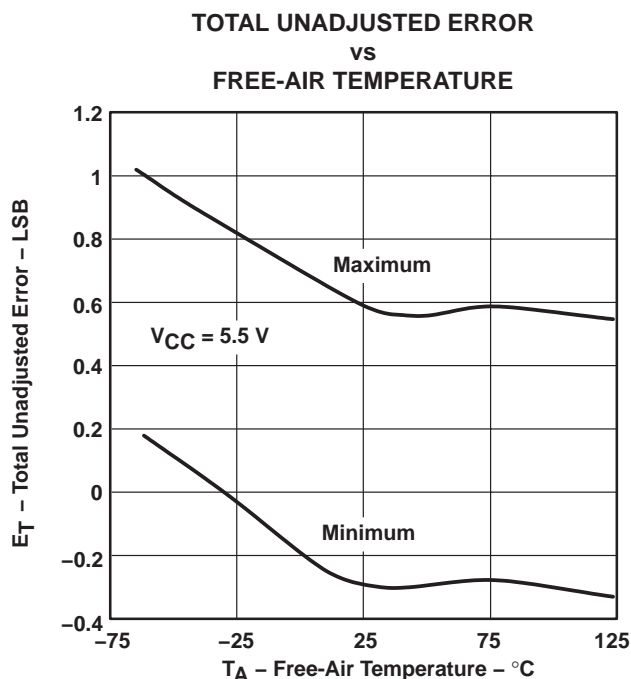
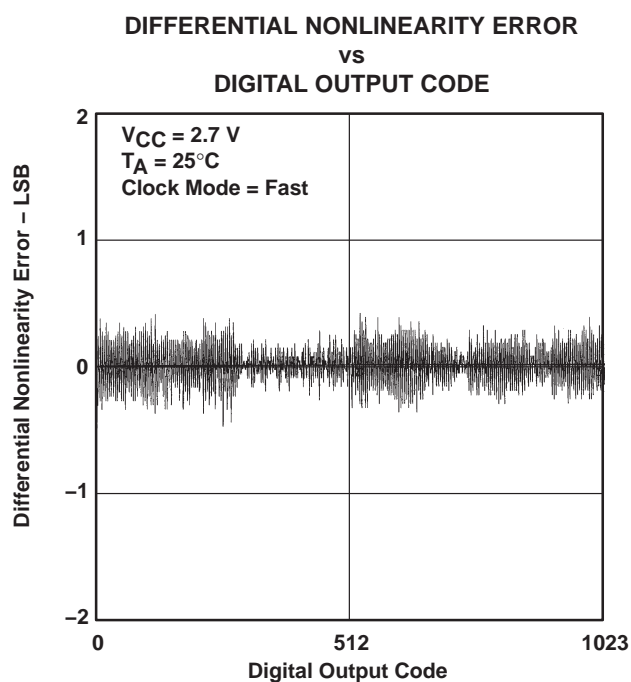
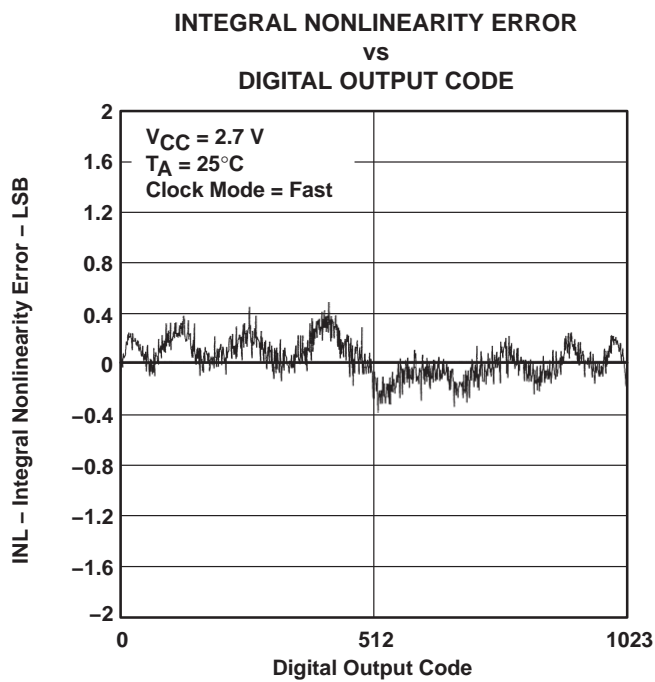
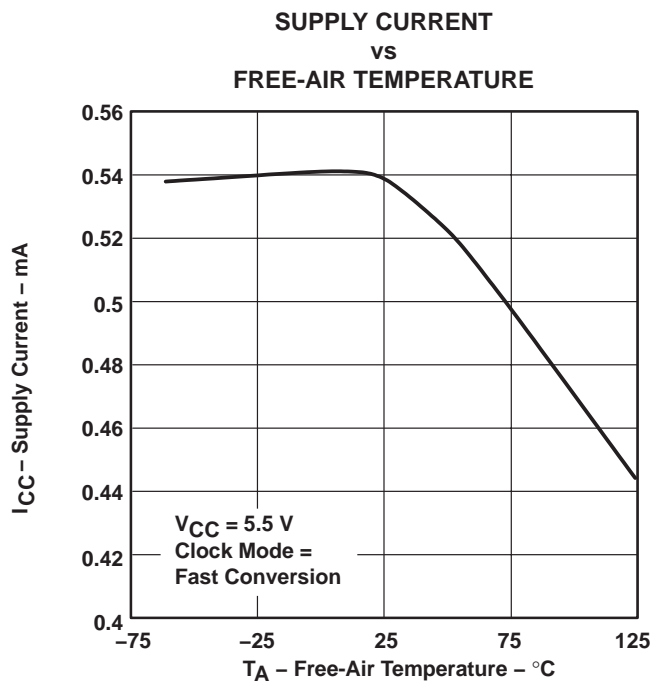


Figure 27



TYPICAL CHARACTERISTICS



TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

TYPICAL CHARACTERISTICS

INTEGRAL NONLINEARITY ERROR
vs
DIGITAL OUTPUT CODE

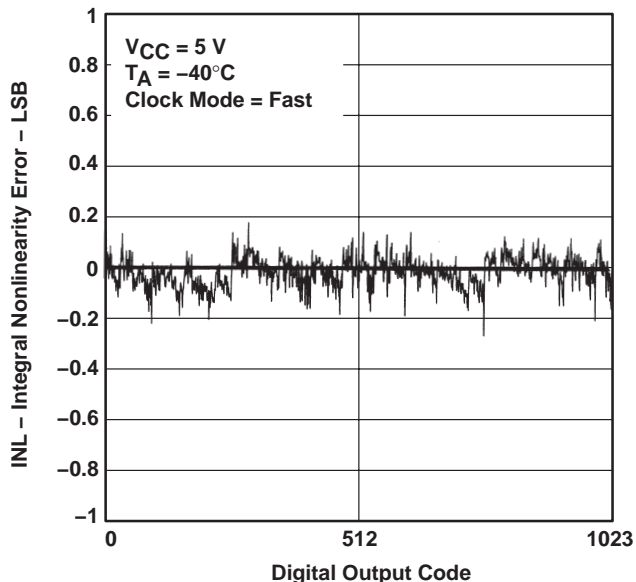


Figure 31

DIFFERENTIAL NONLINEARITY ERROR
vs
DIGITAL OUTPUT CODE

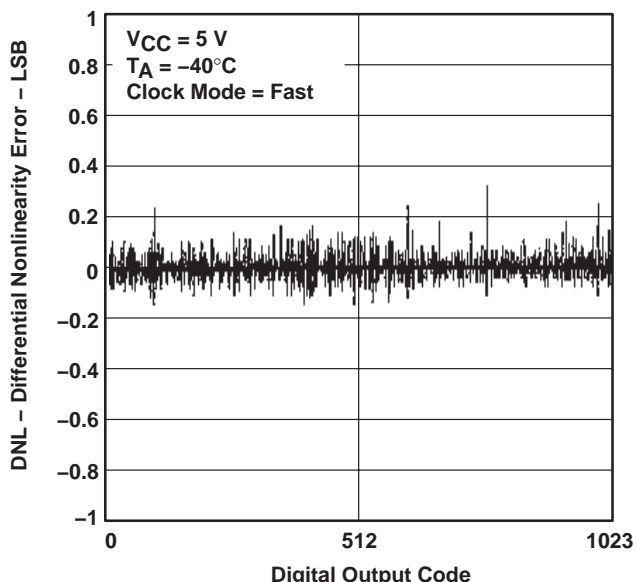


Figure 32

INTEGRAL NONLINEARITY ERROR
vs
DIGITAL OUTPUT CODE

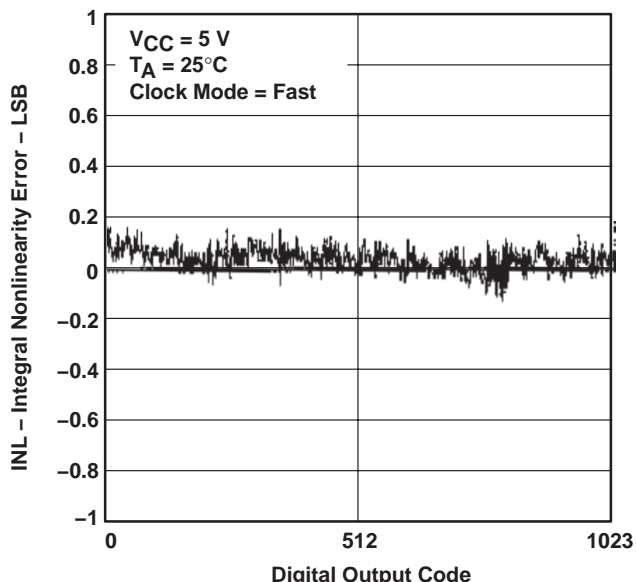


Figure 33

DIFFERENTIAL NONLINEARITY ERROR
vs
DIGITAL OUTPUT CODE

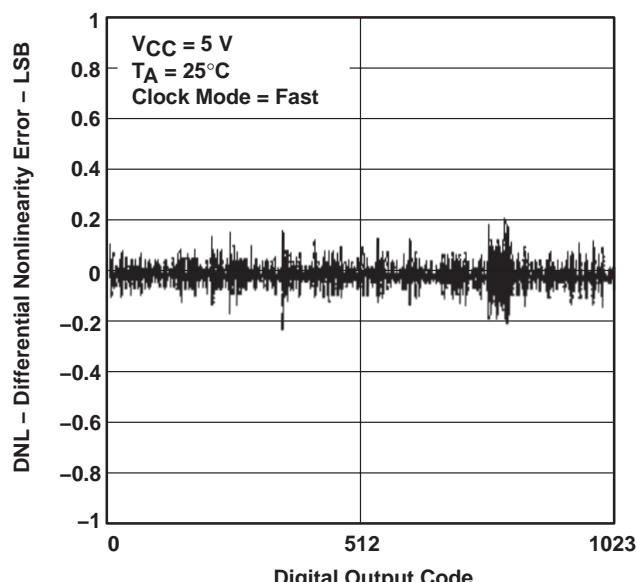


Figure 34



TYPICAL CHARACTERISTICS

INTEGRAL NONLINEARITY ERROR
vs
DIGITAL OUTPUT CODE

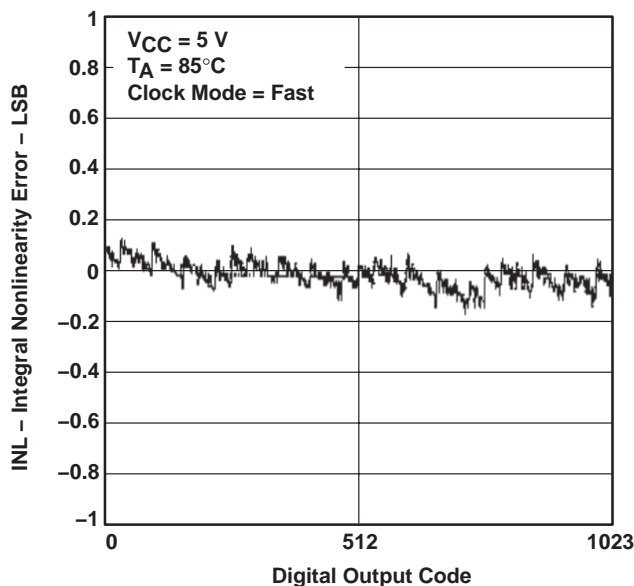


Figure 35

DIFFERENTIAL NONLINEARITY ERROR
vs
DIGITAL OUTPUT CODE

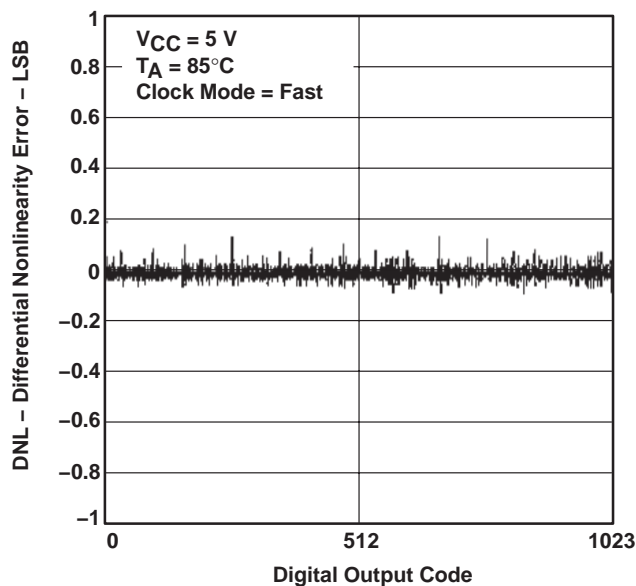
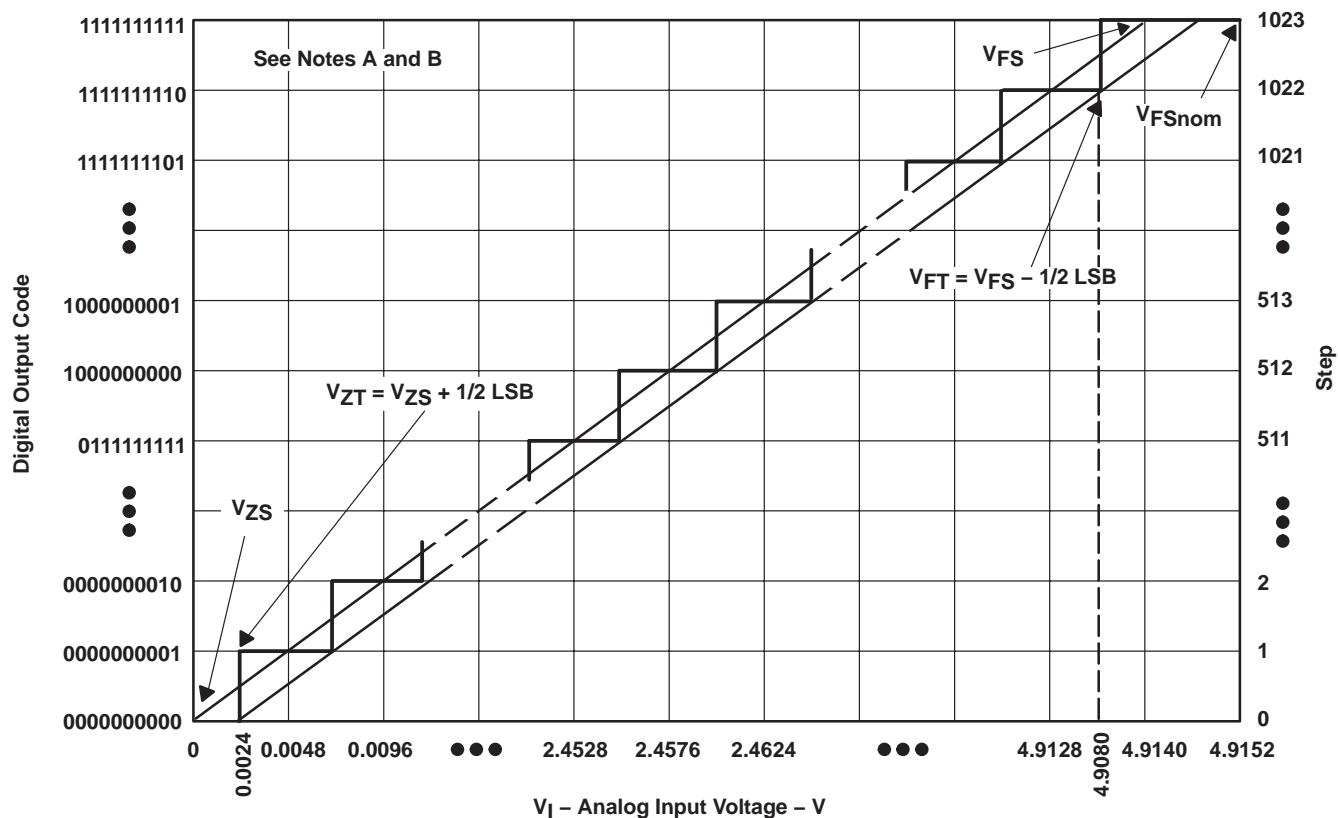


Figure 36

TLV1548-EP
LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER
WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

APPLICATION INFORMATION

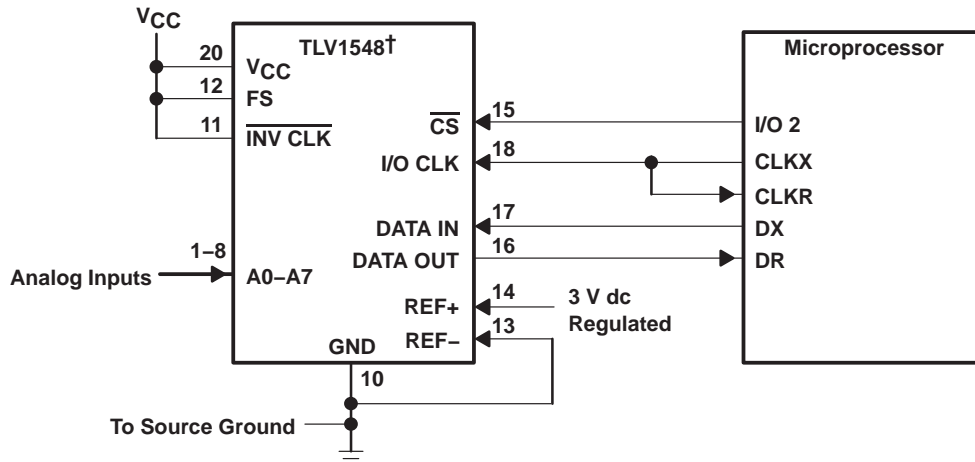


- NOTES: A. This curve is based on the assumption that V_{ref+} and V_{ref-} have been adjusted so that the voltage at the transition from digital 0 to 1 (V_{ZT}) is 0.0024 V, and the transition to full scale (V_{FT}) is 4.908 V. 1 LSB = 4.8 mV.
 B. The full-scale value (V_{FS}) is the step whose nominal midstep value has the highest absolute value. The zero-scale value (V_{ZS}) is the step whose nominal midstep value equals zero.

Figure 37. Ideal Conversion Characteristics

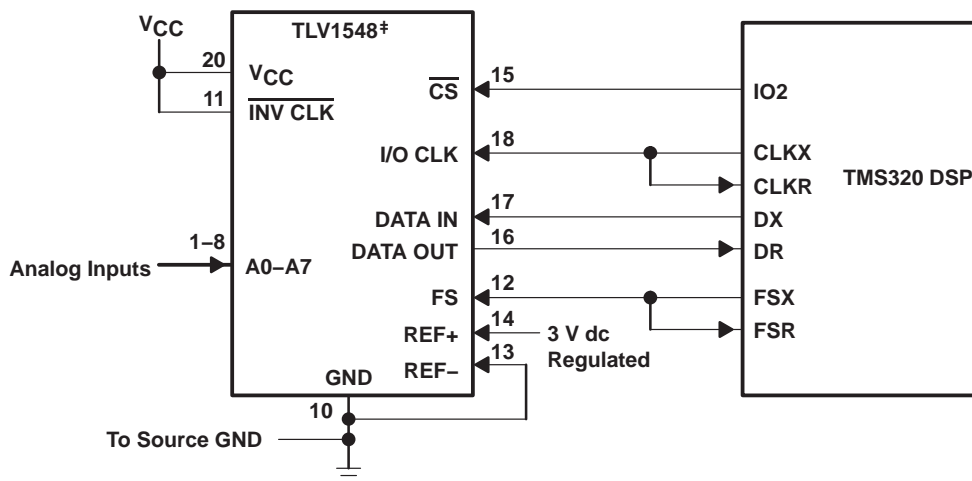


APPLICATION INFORMATION



† DB package is shown for TLV1548

Figure 38. Typical Interface to a Microprocessor



‡ DB package is shown for TLV1548

Figure 39. Typical Interface to a TMS320 DSP

TLV1548-EP

LOW-VOLTAGE 10-BIT ANALOG-TO-DIGITAL CONVERTER WITH SERIAL CONTROL AND 8 ANALOG INPUTS

SGLS171A – JUNE 2003 – REVISED DECEMBER 2003

APPLICATIONS INFORMATION

simplified analog input analysis

Using the equivalent circuit in Figure 33, the time required to charge the analog input capacitance from 0 to V_S within 1/2 LSB can be derived as follows:

The capacitance charging voltage is given by:

$$V_C = V_S \left(1 - e^{-t_c / R_t C_i} \right)$$

where (1)

$$R_t = R_s + r_i$$

$$t_c = \text{Cycle time}$$

The input impedance Z_i is 1 k Ω at 5 V, and is higher (~ 5 k Ω) at 2.7 V. The final voltage to 1/2 LSB is given by:

$$V_C (1/2 \text{ LSB}) = V_S - (V_S/2048) \tag{2}$$

Equating equation 1 to equation 2 and solving for cycle time t_c gives:

$$V_S - (V_S/2048) = V_S \left(1 - e^{-t_c / R_t C_i} \right)$$

(3)

and time to change to 1/2 LSB (minimum sampling time) is:

$$t_{ch} (1/2 \text{ LSB}) = R_t \times C_i \times \ln(2048)$$

where

$$\ln(2048) = 7.625$$

Therefore, with the values given, the time for the analog input signal to settle is:

$$t_{ch} (1/2 \text{ LSB}) = (R_s + 1 \text{ k}\Omega) \times 55 \text{ pF} \times \ln(2048) \tag{4}$$

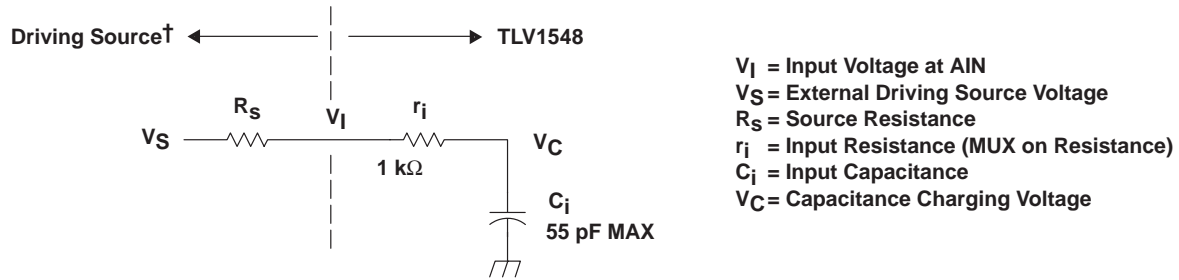
This time must be less than the converter sample time shown in the timing diagrams. Which is 6x I/O CLK.

$$t_{ch} (1/2 \text{ LSB}) \leq 6 \times 1/f_{I/O} \tag{5}$$

Therefore the maximum I/O CLK frequency is:

$$\max(f_{I/O}) = 6 / t_{ch} (1/2 \text{ LSB}) = 6 / (\ln(2048) \times R_t \times C_i) \tag{6}$$

APPLICATIONS INFORMATION



† Driving source requirements:

- Noise and distortion for the source must be equivalent to the resolution of the converter.
- R_S must be real at the input frequency.

Figure 40. Equivalent Input Circuit Including the Driving Source

maximum conversion throughput

For a supply voltage at 5 V, if the source impedance is less than 1 kΩ, this equates to a minimum sampling time t_{ch} (0.5 LSB) of 0.84 μs. Since the sampling time requires six I/O clocks, the fastest I/O clock frequency is $6/t_{ch} = 7.18$ MHz. The minimal total cycle time is given as:

$$\begin{aligned}
 t_c &= t_{\text{address}} + t_{\text{sample}} + t_{\text{conv}} + t_d(\text{EOC}\uparrow - \text{CS}\downarrow) \\
 &= 0.56 \mu\text{s} + 0.84 \mu\text{s} + 10 \mu\text{s} + 0.1 \mu\text{s} \\
 &= 11.5 \mu\text{s}
 \end{aligned}$$

A maximum throughput of 87 KSPS. The throughput can be even higher with a smaller source impedance.

When source impedance is 100Ω, the minimum sampling time is 0.46 μs. The maximum I/O clock frequency possible is almost 13 MHz. Then 10 MHz clock (maximum I/O CLK for TLV1548) can be used. The minimal total cycle time is:

$$\begin{aligned}
 t_c &= t_{\text{address}} + t_{\text{sample}} + t_{\text{conv}} + t_d(\text{EOC}\uparrow - \text{CS}\downarrow) \\
 &= 4 \times 1/f + 0.46 \mu\text{s} + 10 \mu\text{s} + 0.1 \mu\text{s} \\
 &= 0.4 \mu\text{s} + 0.46 \mu\text{s} + 10 \mu\text{s} + 0.1 \mu\text{s} \\
 &= 10.96 \mu\text{s}
 \end{aligned}$$

The maximum throughput is $1/10.96 \mu\text{s} = 91$ KSPS for this case.

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TLV1548QDBREP | ACTIVE | SSOP | DB | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| V62/04618-01XE | ACTIVE | SSOP | DB | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

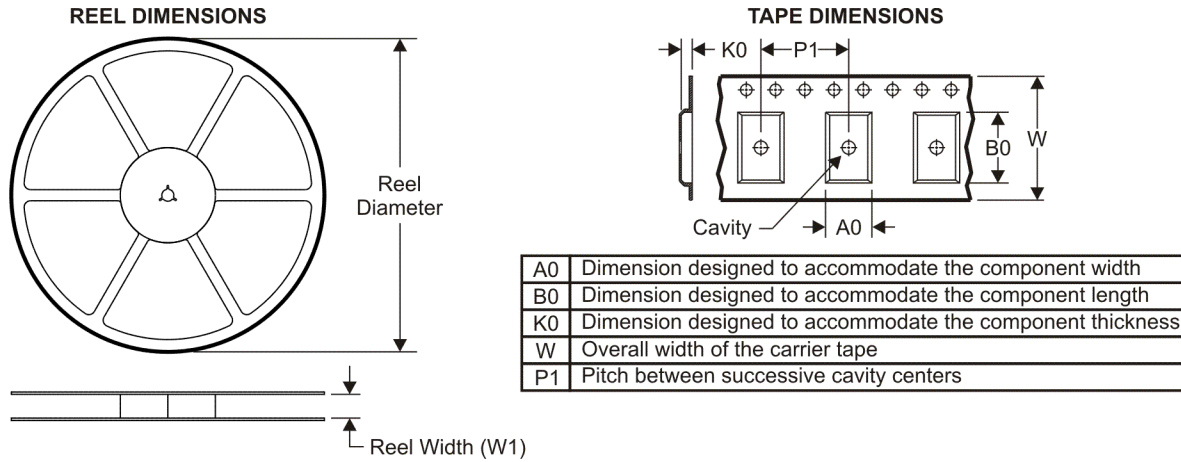
OTHER QUALIFIED VERSIONS OF TLV1548-EP :

- Catalog: [TLV1548](#)
- Automotive: [TLV1548-Q1](#)
- Military: [TLV1548M](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLV1548QDBREP | SSOP | DB | 20 | 2000 | 330.0 | 16.4 | 8.2 | 7.5 | 2.5 | 12.0 | 16.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV1548QDBREP | SSOP | DB | 20 | 2000 | 346.0 | 346.0 | 33.0 |

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

| | |
|-----------------------------|--|
| Amplifiers | amplifier.ti.com |
| Data Converters | dataconverter.ti.com |
| DSP | dsp.ti.com |
| Clocks and Timers | www.ti.com/clocks |
| Interface | interface.ti.com |
| Logic | logic.ti.com |
| Power Mgmt | power.ti.com |
| Microcontrollers | microcontroller.ti.com |
| RFID | www.ti-rfid.com |
| RF/IF and ZigBee® Solutions | www.ti.com/lprf |

Applications

| | |
|--------------------|--|
| Audio | www.ti.com/audio |
| Automotive | www.ti.com/automotive |
| Broadband | www.ti.com/broadband |
| Digital Control | www.ti.com/digitalcontrol |
| Medical | www.ti.com/medical |
| Military | www.ti.com/military |
| Optical Networking | www.ti.com/opticalnetwork |
| Security | www.ti.com/security |
| Telephony | www.ti.com/telephony |
| Video & Imaging | www.ti.com/video |
| Wireless | www.ti.com/wireless |

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2008, Texas Instruments Incorporated